

Project: Design Qualification Test Report	Tracking Code: CR-1261702_Report_Rev_3
Requested by: Patrick Goodwin	Date: 2/19/2026
Part #: NVBM-DP-04-RA-S-2-B-C/NVBF-DP-04-VT-S-2-B-C	
Part description: NVBM/NVBF	Tech: Tony Wagoner
Test Start: 5/12/2025	Test Completed: 6/12/2025



**DESIGN QUALIFICATION TEST REPORT**  
**NVBM/NVBF**  
**NVBM-DP-04-RA-S-2-B-C/NVBF-DP-04-VT-S-2-B-C**

### REVISION HISTORY

DATA	REV.NUM.	DESCRIPTION	ENG
12/8/2025	1	Initial test	KH
2/3/2026	2	Add the M/U/D group test data from CR-1315401	KH
2/13/2026	3	Update Part numbers and CCC Wording	AM

## CERTIFICATION

All instruments and measuring equipment were calibrated to National Institute for Standards and Technology (NIST) traceable standards according to ISO 10012-1 and ANSI/NCSL 2540-1, as applicable.

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### SCOPE

To perform the following tests: Design Qualification test. Please see the test plan.

### APPLICABLE DOCUMENTS

Standards: EIA Publication 364

### TEST SAMPLES AND PREPARATION

- 1) All materials were manufactured in accordance with the applicable product specification.
- 2) All test samples were identified and encoded to maintain traceability throughout the test sequences.
- 3) After soldering, the parts to be used for LLCR and DWV/IR testing were cleaned according to CO-SC-WI-3029.
- 4) Either an automated cleaning procedure or an ultrasonic cleaning procedure may be used.
- 5) The automated procedure is used with aqueous compatible soldering materials.
- 6) Parts not intended for testing LLCR and DWV/IR are visually inspected and cleaned if necessary.
- 7) Any additional preparation will be noted in the individual test sequences.
- 8) Solder Information: Lead Free
- 9) Samtec Test PCBs used: PCB-114550-TST-XX/PCB-113591-TST-XX/PCB-114636-TST-XX.

## FLOWCHARTS

### Gas Tight

#### Group 1

NVBM-DP-04-RA-S-2-B-C

NVBF-DP-04-VT-S-2-B-C

8 Assemblies

Step	Description
1.	LLCR <sup>(2)</sup>
2.	Gas Tight <sup>(1)</sup>
3.	LLCR <sup>(2)</sup> MaxDelta = 15 mOhm



(1) Gas Tight = EIA-364-36

(2) LLCR = EIA-364-23

Open Circuit Voltage = 20 mV Max  
Test Current = 100 mA Max

### Thermal Aging

#### Group 1

NVBM-DP-04-RA-S-2-B-C

NVBF-DP-04-VT-S-2-B-C

8 Assemblies

Step	Description
1.	Contact Gaps
2.	Mating/Unmating Force <sup>(2)</sup>
3.	LLCR <sup>(1)</sup>
4.	Thermal Age <sup>(3)</sup>
5.	LLCR <sup>(1)</sup> MaxDelta = 15 mOhm
6.	Mating/Unmating Force <sup>(2)</sup>
7.	Contact Gaps



(1) LLCR = EIA-364-23

Open Circuit Voltage = 20 mV Max  
Test Current = 100 mA Max

(2) Mating/Unmating Force = EIA-364-13

(3) Thermal Age = EIA-364-17

Test Condition = 4 (105°C)  
Time Condition = B (250 Hours)

### FLOWCHARTS Continued

#### Normal Force

Group 1	Group 2	Group 3	Group 4																																
NVBM-DP-04-RA-S-2-B-C	NVBM-DP-04-RA-S-2-B-C	NVBM-DP-04-RA-S-2-B-C	NVBM-DP-04-RA-S-2-B-C																																
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### FLOWCHARTS Continued

<u>Group 17</u>		<u>Group 18</u>		<u>Group 19</u>		<u>Group 20</u>	
NVBF-DP-04-VT-S-2-B-C		NVBF-DP-04-VT-S-2-B-C		NVBF-DP-04-VT-S-2-B-C		NVBF-DP-04-VT-S-2-B-C	
8 Contacts Minimum Ground Without Thermals Wafer A		8 Contacts Minimum Ground Without Thermals Wafer B		8 Contacts Minimum Ground With Thermals Wafer A		8 Contacts Minimum Ground With Thermals Wafer B	
Step	Description	Step	Description	Step	Description	Step	Description
1.	Contact Gaps	1.	Contact Gaps	1.	Contact Gaps	1.	Contact Gaps
2.	Normal Force <sup>(1)</sup> Expected Force at Max Deflection = 109 8 Deflection = 0.0106"	2.	Normal Force <sup>(1)</sup> Expected Force at Max Deflection = 109 8 Deflection = 0.0106"	2.	Thermal Age <sup>(2)</sup>	2.	Thermal Age <sup>(2)</sup>
				3.	Contact Gaps	3.	Contact Gaps
				4.	Normal Force <sup>(1)</sup> Deflection = 0.0106" Expected Force at Max Deflection = 109 8	4.	Normal Force <sup>(1)</sup> Deflection = 0.0106" Expected Force at Max Deflection = 109 8

(1) Normal Force = EIA-364-04

(2) Thermal Age = EIA-364-17  
Test Condition = 4 (105°C)  
Time Condition = B (250 Hours)

### Current Carrying Capacity

<u>Group 1</u>		<u>Group 2</u>	
NVBM-DP-04-RA-S-2-B-C NVBF-DP-04-VT-S-2-B-C 1 Pins Powered Signal		NVBM-DP-04-RA-S-2-B-C NVBF-DP-04-VT-S-2-B-C 8 Pins Powered Signal	
Step	Description	Step	Description
1.	CCC <sup>(1)</sup> Rows = 1 Number of Positions = 1 <i>Note: Center of connector location</i>	1.	CCC <sup>(1)</sup> Rows = 8 Number of Positions = 1 <i>Note: All signal pins combined carry supply wire all grounds on that wafer carry return</i>

(1) CCC = EIA-364-70

Method 2, Temperature Rise Versus Current Curve  
(TIN PLATING) - Tabulate calculated current at RT, 65°C, 75°C and 95°C after derating 20% and based on 105°C  
(GOLD PLATING) - Tabulate calculated current at RT, 85°C, 95°C and 115°C after derating 20% and based on 125°C

**FLOWCHARTS Continued****Mating/Unmating/Durability****Group 1**

NVBM-DP-04-RA-S-2-B-C

NVBF-DP-04-VT-S-2-B-C

8 Assemblies

Step	Description
1.	Contact Gaps
2.	LLCR <sup>(2)</sup>
3.	Mating/Unmating Force <sup>(3)</sup>
4.	Cycles Quantity = 25 Cycles
5.	Mating/Unmating Force <sup>(3)</sup>
6.	Cycles Quantity = 25 Cycles
7.	Mating/Unmating Force <sup>(3)</sup>
8.	Cycles Quantity = 25 Cycles
9.	Mating/Unmating Force <sup>(3)</sup>
10.	Cycles Quantity = 25 Cycles
11.	Mating/Unmating Force <sup>(3)</sup>
12.	Contact Gaps
13.	LLCR <sup>(2)</sup> Max Delta = 15 mOhm
14.	Thermal Shock <sup>(4)</sup>
15.	LLCR <sup>(2)</sup> Max Delta = 15 mOhm
16.	Humidity <sup>(1)</sup>
17.	LLCR <sup>(2)</sup> Max Delta = 15 mOhm
18.	Mating/Unmating Force <sup>(3)</sup>

(1) Humidity = EIA-364-31

Test Condition = B (240 Hours)

Test Method = III (+25°C to +65°C @ 90% RH to 98% RH)

Test Exceptions: ambient pre-condition and delete steps 7a and 7b

(2) LLCR = EIA-364-23

Open Circuit Voltage = 20 mV Max

Test Current = 100 mA Max

(3) Mating/Unmating Force = EIA-364-13

(4) Thermal Shock = EIA-364-32

Exposure Time at Temperature Extremes = 1/2 Hour

Method A, Test Condition = I (-55°C to +85°C)

Test Duration = A-3 (100 Cycles)

**FLOWCHARTS Continued****Mating/Unmating/Durability**Group 1

NVBF-DP-16-VT-S-2-B-A

NVBM-DP-16-RA-S-2-B-A

8 Assemblies

Step	Description
1.	Contact Gaps
2.	LLCR (2)
3.	Mating/Unmating Force (3)
4.	Cycles Quantity = 25 Cycles
5.	Mating/Unmating Force (3)
6.	Cycles Quantity = 25 Cycles
7.	Mating/Unmating Force (3)
8.	Cycles Quantity = 25 Cycles
9.	Mating/Unmating Force (3)
10.	Cycles Quantity = 25 Cycles
11.	Mating/Unmating Force (3)
12.	Contact Gaps
13.	LLCR (2) Max Delta = 15 mOhm
14.	Thermal Shock (4)
15.	LLCR (2) Max Delta = 15 mOhm
16.	Humidity (1)
17.	LLCR (2) Max Delta = 15 mOhm
18.	Mating/Unmating Force (3)

(1) Humidity = EIA-364-31

Test Condition = B (240 Hours)

Test Method = III (+25°C to +65°C @ 90% RH to 98% RH)

Test Exceptions: ambient pre-condition and delete steps 7a and 7b

(2) LLCR = EIA-364-23

Open Circuit Voltage = 20 mV Max

Test Current = 100 mA Max

(3) Mating/Unmating Force = EIA-364-13

(4) Thermal Shock = EIA-364-32

Exposure Time at Temperature Extremes = 1/2 Hour

Method A, Test Condition = I (-55°C to +85°C)

Test Duration = A-3 (100 Cycles)

**FLOWCHARTS Continued****IR/DWV***Note: IR = 100V Test Voltage**Note: DWV = 450V Test Voltage***Pin-to-Pin****Group 1**

NVBM-DP-04-RA-S-2-B-C

NVBF-DP-04-VT-S-2-B-C

2 Assemblies

**Row-to-Row****Group 2**

NVBM-DP-04-RA-S-2-B-C

NVBF-DP-04-VT-S-2-B-C

2 Assemblies

Step	Description
1.	IR <sup>(3)</sup> - Non Standard
2.	DWV at Test Voltage <sub>(1)</sub>
3.	Thermal Shock <sub>(4)</sub>
4.	IR <sup>(3)</sup> - Non Standard
5.	DWV at Test Voltage <sub>(1)</sub>
6.	Humidity <sup>(2)</sup>
7.	IR <sup>(3)</sup> - Non Standard
8.	DWV at Test Voltage <sub>(1)</sub>

Step	Description
1.	IR <sup>(3)</sup> - Non Standard
2.	DWV at Test Voltage <sub>(1)</sub>
3.	Thermal Shock <sub>(4)</sub>
4.	IR <sup>(3)</sup> - Non Standard
5.	DWV at Test Voltage <sub>(1)</sub>
6.	Humidity <sup>(2)</sup>
7.	IR <sup>(3)</sup> - Non Standard
8.	DWV at Test Voltage <sub>(1)</sub>

**Pin-to-Ground****Group 3**

NVBM-DP-04-RA-S-2-B-C

NVBF-DP-04-VT-S-2-B-C

2 Assemblies

Step	Description
1.	IR <sup>(3)</sup> - Non Standard
2.	DWV at Test Voltage <sub>(1)</sub>
3.	Thermal Shock <sub>(4)</sub>
4.	IR <sup>(3)</sup> - Non Standard
5.	DWV at Test Voltage <sub>(1)</sub>
6.	Humidity <sup>(2)</sup>
7.	IR <sup>(3)</sup> - Non Standard
8.	DWV at Test Voltage <sub>(1)</sub>

- (1) DWV at Test Voltage = EIA-364-20  
Test Condition = 1 (Sea Level)  
DWV test voltage is equal to 75% of the lowest breakdown voltage  
Test voltage applied for 60 seconds
- (2) Humidity = EIA-364-31  
Test Condition = B (240 Hours)  
Test Method = III (+25°C to +65°C @ 90% RH to 98% RH)  
Test Exceptions: ambient pre-condition and delete steps 7a and 7b
- (3) IR = Other  
Test Condition = 100 Vdc, 2 Minutes Max
- (4) Thermal Shock = EIA-364-32  
Exposure Time at Temperature Extremes = 1/2 Hour  
Method A, Test Condition = I (-55°C to +85°C)  
Test Duration = A-3 (100 Cycles)

**FLOWCHARTS Continued****Mechanical Shock/Random Vibration/LLCR**Group 1

NVBM-DP-04-RA-S-2-B-C

NVBF-DP-04-VT-S-2-B-C

8 Assemblies

**Step Description**

1. LLCR<sup>(1)</sup>
2. Mechanical Shock<sup>(2)</sup>
3. Random Vibration<sup>(3)</sup>
4. LLCR<sup>(1)</sup>  
Max Delta = 15 mOhm

**(1) LLCR = EIA-364-23**

Open Circuit Voltage = 20 mV Max

Test Current = 100 mA Max

**(2) Mechanical Shock = EIA-364-27**

Test Condition = C (100 G Peak, 6 milliseconds, Half Sine)

Number of Shocks = 3 Per Direction, Per Axis, 18 Total

**(3) Random Vibration = EIA-364-28**

Condition = VB (7.56 gRMS Average, 2 Hours/Axis)

**Mechanical Shock/Random Vibration/Event Detection**Group 1

NVBM-DP-04-RA-S-2-B-C

NVBF-DP-04-VT-S-2-B-C

60 Points

**Step Description**

1. Nanosecond Event Detection  
(Mechanical Shock)<sup>(1)</sup>
2. Nanosecond Event Detection  
(Random Vibration)<sup>(2)</sup>

**(1) Nanosecond Event Detection (Mechanical Shock)**

Use EIA-364-87 for Nanosecond Event Detection:

Test Condition = F (50 nanoseconds at 10 ohms)

Use EIA-364-27 for Mechanical Shock:

Test Condition = C (100 G Peak, 6 milliseconds, Half Sine)

Number of Shocks = 3 Per Direction, Per Axis, 18 Total

**(2) Nanosecond Event Detection (Random Vibration)**

Use EIA-364-87 for Nanosecond Event Detection:

Test Condition = F (50 nanoseconds at 10 ohms)

Use EIA-364-28 for Random Vibration:

Condition = VB (7.56 gRMS Average, 2 Hours/Axis)

## ATTRIBUTE DEFINITIONS

The following is a brief, simplified description of attributes.

### THERMAL:

- 1) EIA-364-17, *Temperature Life with or without Electrical Load Test Procedure for Electrical Connectors*.
- 2) Test Condition at 105° C.
- 3) Test Time Condition B for 250 hours.
- 4) All test samples are pre-conditioned at ambient.
- 5) All test samples are exposed to environmental stress in mated conditions.

### THERMAL SHOCK:

- 1) EIA-364-32, *Thermal Shock (Temperature Cycling) Test Procedure for Electrical Connectors*.
- 2) Test Condition I: -55°C to +85°C.
- 3) Test Time: ½ hour dwell at each temperature extreme.
- 4) Number of Cycles: 100
- 5) All test samples are pre-conditioned at ambient.
- 6) All test samples are exposed to environmental stress in mated conditions.

### HUMIDITY:

- 1) Reference document: EIA-364-31, *Humidity Test Procedure for Electrical Connectors*.
- 2) Test Condition B, 240 Hours.
- 3) Method III, +25° C to + 65° C, 90% to 98% Relative Humidity excluding sub-cycles 7a and 7b.
- 4) All samples are pre-conditioned at ambient.
- 5) All test samples are exposed to environmental stress in mated conditions.

### MECHANICAL SHOCK (Specified Pulse):

- 1) Reference document: EIA-364-27, *Mechanical Shock Test Procedure for Electrical Connectors*
- 2) Test Condition C
- 3) Peak Value: 100 G
- 4) Duration: 6 Milliseconds
- 5) Wave Form: Half Sine
- 6) Velocity: 12.3 ft/s
- 7) Number of Shocks: 3 Shocks / Direction, 3 Axis (18 Total)

### VIBRATION:

- 1) Reference document: EIA-364-28, *Vibration Test Procedure for Electrical Connectors*
- 2) Test Condition V, Letter B
- 3) Power Spectral Density: 0.04 G<sup>2</sup> / Hz
- 4) G 'RMS': 7.56
- 5) Frequency: 50 to 2000 Hz
- 6) Duration: 2.0 Hours per axis (3 axis total)

### NANOSECOND-EVENT DETECTION:

- 1) Reference document: EIA-364-87, *Nanosecond-Event Detection for Electrical Connectors*
- 2) Prior to testing, the samples were characterized to ensure the low nanosecond event being monitored will trigger the detector.
- 3) After characterization it was determined the test samples could be monitored for 50 nanosecond events

### MATING/UNMATING:

- 1) Reference document: EIA-364-13, *Mating and Unmating Forces Test Procedure for Electrical Connectors*.
- 2) The full insertion position was to within 0.003" to 0.004" of the plug bottoming out in the receptacle to prevent damage to the system under test.
- 3) One of the mating parts is secured to a floating X-Y table to prevent damage during cycling.

### ATTRIBUTE DEFINITIONS Continued

The following is a brief, simplified description of attributes.

#### **NORMAL FORCE (FOR CONTACTS TESTED IN THE HOUSING):**

- 1) Reference document: EIA-364-04, *Normal Force Test Procedure for Electrical Connectors*.
- 2) The contacts shall be tested in the connector housing.
- 3) If necessary, a "window" shall be made in the connector body to allow a probe to engage and deflect the contact at the same attitude and distance (plus 0.05 mm [0.002"]) as would occur in actual use.
- 4) The connector housing shall be placed in a holding fixture that does not interfere with or otherwise influence the contact force or deflection.
- 5) Said holding fixture shall be mounted on a floating, adjustable, X-Y table on the base of the Dillon TC<sup>2</sup>, computer-controlled test stand with a deflection measurement system accuracy of 5.0 μm (0.0002").
- 6) The nominal deflection rate shall be 5 mm (0.2")/minute.
- 7) Unless otherwise noted a minimum of five contacts shall be tested.
- 8) The force/deflection characteristic to load and unload each contact shall be repeated five times.
- 9) The system should utilize the TC<sup>2</sup> software in order to acquire and record the test data.
- 10) The permanent set of each contact shall be measured within the TC<sup>2</sup> software.
- 11) The acquired data shall be graphed with the deflection data on the X-axis and the force data on the Y-axis and a printout will be stored with the Tracking Code paperwork.

#### **TEMPERATURE RISE (Current Carrying Capacity, CCC):**

- 1) EIA-364-70, *Temperature Rise versus Current Test Procedure for Electrical Connectors and Sockets*.
- 2) When current passes through a contact, the temperature of the contact increases as a result of  $I^2R$  (resistive) heating.
- 3) The number of contacts being investigated plays a significant part in power dissipation and therefore temperature rise.
- 4) The size of the temperature probe can affect the measured temperature.
- 5) Copper traces on PC boards will contribute to temperature rise:
  - a. Self-heating (resistive)
  - b. Reduction in heat sink capacity affecting the heated contacts
- 6) A de-rating curve, usually 20%, is calculated.
- 7) Calculated de-rated currents at four temperature points are reported:
  - a. Ambient
  - b. 85° C
  - c. 95° C
  - d. 115° C
- 8) Typically, neighboring contacts (in close proximity to maximize heat buildup) are energized.
- 9) The thermocouple (or temperature measuring probe) will be positioned at a location to sense the maximum temperature in the vicinity of the heat generation area.
- 10) A computer program, *TR 803.exe*, ensures accurate stability for data acquisition.
- 11) Hook-up wire cross section is larger than the cross section of any connector leads/PC board traces, jumpers, etc.
- 12) Hook-up wire length is longer than the minimum specified in the referencing standard.

**ATTRIBUTE DEFINITIONS Continued**

The following is a brief, simplified description of attributes.

**LLCR:**

- 1) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 2) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 3) The following guidelines are used to categorize the changes in LLCR as a result of stress.
  - a.  $\leq +5.0$  mOhms: -----Stable
  - b.  $+5.1$  to  $+10.0$  mOhms:-----Minor
  - c.  $+10.1$  to  $+15.0$  mOhms: -----Acceptable
  - d.  $+15.1$  to  $+50.0$  mOhms: -----Marginal
  - e.  $+50.1$  to  $+1000$  mOhms: -----Unstable
  - f.  $>+1000$  mOhms:-----Open Failure

**GAS TIGHT:**

To provide method for evaluating the ability of the contacting surfaces in preventing penetration of harsh vapors which might lead to oxide formation that may degrade the electrical performance of the contact system.

- 1) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 2) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 3) The following guidelines are used to categorize the changes in LLCR as a result of stress.
  - a.  $\leq +5.0$  mOhms:-----Stable
  - b.  $+5.1$  to  $+10.0$  mOhms: -----Minor
  - c.  $+10.1$  to  $+15.0$  mOhms: -----Acceptable
  - d.  $+15.1$  to  $+50.0$  mOhms: -----Marginal
  - e.  $+50.1$  to  $+1000$  mOhms:-----Unstable
  - f.  $>+1000$  mOhms:-----Open Failure
- 4) Procedure:
  - a. Reference document: EIA-364-36, *Test Procedure for Determination of Gas-Tight Characteristics for Electrical Connectors, Sockets and/or Contact Systems*.
  - b. Test Conditions:
    - i. Class II--- Mated pairs of contacts assembled to their plastic housing.
    - ii. Reagent grade Nitric Acid shall be used of sufficient volume to saturate the test chamber.
    - iii. The ratio of the volume of the test chamber to the surface area of the acid shall be 10:1.
    - iv. The chamber shall be saturated with the vapor for at least 15 minutes before samples are added.
    - v. Exposure time, 55 to 65 minutes.
    - vi. The samples shall be no closer to the chamber walls than 1 inch and no closer to the surface of the acid than 3 inches.
    - vii. The samples shall be dried after exposure for a minimum of 1 hour.
    - viii. Drying temperature  $50^{\circ}$  C
    - ix. The final LLCR shall be conducted within 1 hour after drying.

### ATTRIBUTE DEFINITIONS Continued

The following is a brief, simplified description of attributes.

#### INSULATION RESISTANCE (IR):

To determine the resistance of insulation materials to leakage of current through or on the surface of these materials when a DC potential is applied.

- 1) PROCEDURE:
  - a. Reference document: EIA-364-21, *Insulation Resistance Test Procedure for Electrical Connectors*.
  - b. Test Conditions:
    - i. Between Adjacent Contacts or Signal-to-Ground
    - ii. Electrification Time 2.0 minutes
    - iii. Test Voltage (100 VDC) corresponds to calibration settings for measuring resistances.
- 2) MEASUREMENTS:
- 3) When the specified test voltage is applied (VDC), the insulation resistance shall not be less than 5000 megohms.

#### DIELECTRIC WITHSTANDING VOLTAGE (DWV):

To determine if the sockets can operate at their rated voltage and withstand momentary over potential due to switching, surges, and another similar phenomenon. Separate samples are used to evaluate the effect of environmental stresses so not to influence the readings from arcing that occurs during the measurement process.

- 1) PROCEDURE:
  - a. Reference document: EIA-364-20, *Withstanding Voltage Test Procedure for Electrical Connectors*.
  - b. Test Conditions:
    - i. Between Adjacent Contacts or Signal-to-Ground
    - ii. Barometric Test Condition 1
    - iii. Rate of Application 500 V/Sec
    - iv. Test Voltage (VAC) until breakdown occurs.
- 2) MEASUREMENTS/CALCULATIONS
  - a. The breakdown voltage shall be measured and recorded.
  - b. The dielectric withstanding voltage shall be recorded as 75% of the minimum breakdown voltage.
  - c. The working voltage shall be recorded as one-third (1/3) of the dielectric withstanding voltage (one-fourth of the breakdown voltage).

## RESULTS

### Temperature Rise, CCC at a 20% de-rating

- CCC for a 30°C Temperature Rise-----3.5 A per contact with 1 contact (1 x 1) powered
- CCC for a 30°C Temperature Rise-----9.2 A per wafer (1.15A per Signal Pin) with 8 contacts (1 x 8) powered - NOTE: (All Signal Pins Combined Carry Supply while all Grounds on that Wafer Carry Return)

### Mating – Unmating Forces

#### Thermal Aging Group

- **Initial**
  - **Mating**
    - **Min** ----- 2.67 lbs
    - **Max** ----- 3.32 lbs
  - **Unmating**
    - **Min** ----- 2.20 lbs
    - **Max** ----- 2.68 lbs
- **After Thermal**
  - **Mating**
    - **Min** ----- 1.60 lbs
    - **Max** ----- 1.87 lbs
  - **Unmating**
    - **Min** ----- 1.29 lbs
    - **Max** ----- 1.46 lbs

**RESULTS Continued****Mating/Unmating Durability Group (NVBM-DP-04-RA-S-2-B-C/NVBF-DP-04-VT-S-2-B-C)**

- **Initial**
  - **Mating**
    - **Min** ----- 2.61 lbs
    - **Max** ----- 3.22 lbs
  - **Unmating**
    - **Min** ----- 1.98 lbs
    - **Max** ----- 2.45 lbs
- **After 25 Cycles**
  - **Mating**
    - **Min** ----- 3.27 lbs
    - **Max** ----- 3.59 lbs
  - **Unmating**
    - **Min** ----- 2.38 lbs
    - **Max** ----- 2.67 lbs
- **After 50 Cycles**
  - **Mating**
    - **Min** ----- 3.20 lbs
    - **Max** ----- 3.62 lbs
  - **Unmating**
    - **Min** ----- 2.49 lbs
    - **Max** ----- 2.82 lbs
- **After 75 Cycles**
  - **Mating**
    - **Min** ----- 3.20 lbs
    - **Max** ----- 3.59 lbs
  - **Unmating**
    - **Min** ----- 2.55 lbs
    - **Max** ----- 2.97 lbs
- **After 100 Cycles**
  - **Mating**
    - **Min** ----- 3.19 lbs
    - **Max** ----- 3.66 lbs
  - **Unmating**
    - **Min** ----- 2.62 lbs
    - **Max** ----- 3.01 lbs
- **After Humidity**
  - **Mating**
    - **Min** ----- 1.72 lbs
    - **Max** ----- 2.05 lbs
  - **Unmating**
    - **Min** ----- 1.45 lbs
    - **Max** ----- 1.78 lbs

**RESULTS Continued****Mating/Unmating Durability Group (NVBM-DP-16-RA-S-2-B-A/NVBF-DP-16-VT-S-2-B-A)**

- **Initial**
  - **Mating**
    - **Min** ----- 8.91 lbs
    - **Max** ----- 10.57 lbs
  - **Unmating**
    - **Min** ----- 7.40 lbs
    - **Max** ----- 8.68 lbs
- **After 25 Cycles**
  - **Mating**
    - **Min** ----- 10.74 lbs
    - **Max** ----- 12.66 lbs
  - **Unmating**
    - **Min** ----- 8.90 lbs
    - **Max** ----- 10.55 lbs
- **After 50 Cycles**
  - **Mating**
    - **Min** ----- 11.22 lbs
    - **Max** ----- 12.90 lbs
  - **Unmating**
    - **Min** ----- 9.32 lbs
    - **Max** ----- 10.93 lbs
- **After 75 Cycles**
  - **Mating**
    - **Min** ----- 11.45 lbs
    - **Max** ----- 13.29 lbs
  - **Unmating**
    - **Min** ----- 9.57 lbs
    - **Max** ----- 11.13 lbs
- **After 100 Cycles**
  - **Mating**
    - **Min** ----- 11.79 lbs
    - **Max** ----- 13.67 lbs
  - **Unmating**
    - **Min** ----- 9.87 lbs
    - **Max** ----- 11.40 lbs
- **After Humidity**
  - **Mating**
    - **Min** ----- 7.89 lbs
    - **Max** ----- 8.73 lbs
  - **Unmating**
    - **Min** ----- 6.71 lbs
    - **Max** ----- 7.35 lbs



**RESULTS Continued****Normal Force****NVBF Signal pin SH164-B at 0.0106 inches deflection**

- **Initial**
  - **Min**-----86.50 gf      **Set**----- 0.0003 inch.
  - **Max**-----113.50 gf      **Set**----- 0.0004 inch.
- **After Thermal**
  - **Min**-----66.50 gf      **Set**----- 0.0017 inch.
  - **Max**-----89.00 gf      **Set**----- 0.0024 inch.

**NVBF Ground pin SH164-B at 0.0106 inches deflection**

- **Initial**
  - **Min**-----70.00 gf      **Set**----- 0.0000 inch.
  - **Max**-----88.00 gf      **Set**----- 0.0002 inch.
- **After Thermal**
  - **Min**-----67.30 gf      **Set**----- 0.0005 inch.
  - **Max**-----79.50 gf      **Set**----- 0.0014 inch.

**NVBF MFBL SH164-B at 0.0200 inches deflection**

- **Initial**
  - **Min**-----83.00 gf      **Set**----- 0.0003 inch.
  - **Max**-----96.00 gf      **Set**----- 0.0011 inch.
- **After Thermal**
  - **Min**-----75.70 gf      **Set**----- 0.0027 inch.
  - **Max**-----84.10 gf      **Set**----- 0.0040 inch.

**RESULTS Continued****Insulation Resistance minimums, IR****Pin to Pin 1**

- **Initial**
  - Mated----- 9000 Meg  $\Omega$  ----- Passed
  - Unmated ----- 9000 Meg  $\Omega$  ----- Passed
- **Thermal Shock**
  - Mated----- 9000 Meg  $\Omega$  ----- Passed
  - Unmated ----- 9000 Meg  $\Omega$  ----- Passed
- **Humidity**
  - Mated----- 9000 Meg  $\Omega$  ----- Passed
  - Unmated ----- 6300 Meg  $\Omega$  ----- Passed

**Pin to Pin 2**

- **Initial**
  - Mated----- 9000 Meg  $\Omega$  ----- Passed
  - Unmated ----- 9000 Meg  $\Omega$  ----- Passed
- **Thermal Shock**
  - Mated----- 9000 Meg  $\Omega$  ----- Passed
  - Unmated ----- 9000 Meg  $\Omega$  ----- Passed
- **Humidity**
  - Mated----- 9000 Meg  $\Omega$  ----- Passed
  - Unmated ----- 9000 Meg  $\Omega$  ----- Passed

**Row to Row**

- **Initial**
  - Mated----- 9000 Meg  $\Omega$  ----- Passed
  - Unmated ----- 9000 Meg  $\Omega$  ----- Passed
- **Thermal Shock**
  - Mated----- 9000 Meg  $\Omega$  ----- Passed
  - Unmated ----- 9000 Meg  $\Omega$  ----- Passed
- **Humidity**
  - Mated----- 9000 Meg  $\Omega$  ----- Passed
  - Unmated ----- 9000 Meg  $\Omega$  ----- Passed

**Pin to Ground 1**

- **Initial**
  - Mated----- 9000 Meg  $\Omega$  ----- Passed
  - Unmated ----- 9000 Meg  $\Omega$  ----- Passed
- **Thermal Shock**
  - Mated----- 9000 Meg  $\Omega$  ----- Passed
  - Unmated ----- 9000 Meg  $\Omega$  ----- Passed
- **Humidity**
  - Mated----- 5700 Meg  $\Omega$  ----- Passed
  - Unmated ----- 5700 Meg  $\Omega$  ----- Passed

**Pin to Ground 2**

- **Initial**
  - Mated----- 9000 Meg  $\Omega$  ----- Passed
  - Unmated ----- 9000 Meg  $\Omega$  ----- Passed
- **Thermal Shock**
  - Mated----- 9000 Meg  $\Omega$  ----- Passed
  - Unmated ----- 9000 Meg  $\Omega$  ----- Passed
- **Humidity**
  - Mated----- 9000 Meg  $\Omega$  ----- Passed
  - Unmated ----- 9000 Meg  $\Omega$  ----- Passed

### RESULTS Continued

#### Dielectric Withstanding Voltage minimums, DWV

- **Minimums**
  - Breakdown Voltage-----600 VAC
  - Test Voltage -----450 VAC
  - Working Voltage -----150 VAC

#### Pin to Pin 1

- Initial DWV -----Passed
- Thermal DWV -----Passed
- Humidity DWV-----Passed

#### Pin to Pin 2

- Initial DWV -----Passed
- Thermal DWV -----Passed
- Humidity DWV-----Passed

#### Row to Row

- Initial DWV -----Passed
- Thermal DWV -----Passed
- Humidity DWV-----Passed

#### Pin to Ground 1

- Initial DWV -----Passed
- Thermal DWV -----Passed
- Humidity DWV-----Passed

#### Pin to Ground 2

- Initial DWV -----Passed
- Thermal DWV -----Passed
- Humidity DWV-----Passed

**RESULTS Continued****LLCR Gas Tight (160 signal and 32 ground LLCR test points)****Signal pin**

- Initial ----- 28.11 mOhms Max
- Gas-Tight
  - $\leq +5.0$  mOhms ----- 160 Points ----- Stable
  - $+5.1$  to  $+10.0$  mOhms ----- 0 Points ----- Minor
  - $+10.1$  to  $+15.0$  mOhms ----- 0 Points ----- Acceptable
  - $+15.1$  to  $+50.0$  mOhms ----- 0 Points ----- Marginal
  - $+50.1$  to  $+1000$  mOhms ----- 0 Points ----- Unstable
  - $>+1000$  mOhms ----- 0 Points ----- Open Failure

**Ground pin**

- Initial ----- 7.19 mOhms Max
- Gas-Tight
  - $\leq +5.0$  mOhms ----- 32 Points ----- Stable
  - $+5.1$  to  $+10.0$  mOhms ----- 0 Points ----- Minor
  - $+10.1$  to  $+15.0$  mOhms ----- 0 Points ----- Acceptable
  - $+15.1$  to  $+50.0$  mOhms ----- 0 Points ----- Marginal
  - $+50.1$  to  $+1000$  mOhms ----- 0 Points ----- Unstable
  - $>+1000$  mOhms ----- 0 Points ----- Open Failure

**LLCR Thermal Aging (256 signal and 32 ground LLCR test points)****Signal pin**

- Initial ----- 27.6 mOhms Max
- Thermal Aging
  - $\leq +5.0$  mOhms ----- 241 Points ----- Stable
  - $+5.1$  to  $+10.0$  mOhms ----- 15 Points ----- Minor
  - $+10.1$  to  $+15.0$  mOhms ----- 0 Points ----- Acceptable
  - $+15.1$  to  $+50.0$  mOhms ----- 0 Points ----- Marginal
  - $+50.1$  to  $+1000$  mOhms ----- 0 Points ----- Unstable
  - $>+1000$  mOhms ----- 0 Points ----- Open Failure

**Ground pin**

- Initial ----- 6.93 mOhms Max
- Thermal Aging
  - $\leq +5.0$  mOhms ----- 32 Points ----- Stable
  - $+5.1$  to  $+10.0$  mOhms ----- 0 Points ----- Minor
  - $+10.1$  to  $+15.0$  mOhms ----- 0 Points ----- Acceptable
  - $+15.1$  to  $+50.0$  mOhms ----- 0 Points ----- Marginal
  - $+50.1$  to  $+1000$  mOhms ----- 0 Points ----- Unstable
  - $>+1000$  mOhms ----- 0 Points ----- Open Failure

**RESULTS Continued****LLCR Durability (256 signal and 32 ground LLCR test points)****NVBM-DP-04-RA-S-2-B-C/NVBF-DP-04-VT-S-2-B-C****Signal pin**

- **Initial**----- 27.81 mOhms Max
- **Durability, 100 Cycles**
  - **<= +5.0 mOhms**----- 256 Points ----- Stable
  - **+5.1 to +10.0 mOhms**----- 0 Points ----- Minor
  - **+10.1 to +15.0 mOhms**----- 0 Points ----- Acceptable
  - **+15.1 to +50.0 mOhms**----- 0 Points ----- Marginal
  - **+50.1 to +1000 mOhms**----- 0 Points ----- Unstable
  - **>+1000 mOhms**----- 0 Points ----- Open Failure
- **Thermal**
  - **<= +5.0 mOhms**----- 256 Points ----- Stable
  - **+5.1 to +10.0 mOhms**----- 0 Points ----- Minor
  - **+10.1 to +15.0 mOhms**----- 0 Points ----- Acceptable
  - **+15.1 to +50.0 mOhms**----- 0 Points ----- Marginal
  - **+50.1 to +1000 mOhms**----- 0 Points ----- Unstable
  - **>+1000 mOhms**----- 0 Points ----- Open Failure
- **Humidity**
  - **<= +5.0 mOhms**----- 256 Points ----- Stable
  - **+5.1 to +10.0 mOhms**----- 0 Points ----- Minor
  - **+10.1 to +15.0 mOhms**----- 0 Points ----- Acceptable
  - **+15.1 to +50.0 mOhms**----- 0 Points ----- Marginal
  - **+50.1 to +1000 mOhms**----- 0 Points ----- Unstable
  - **>+1000 mOhms**----- 0 Points ----- Open Failure

**Ground pin**

- **Initial**----- 6.93 mOhms Max
- **Durability, 100 Cycles**
  - **<= +5.0 mOhms**----- 32 Points ----- Stable
  - **+5.1 to +10.0 mOhms**----- 0 Points ----- Minor
  - **+10.1 to +15.0 mOhms**----- 0 Points ----- Acceptable
  - **+15.1 to +50.0 mOhms**----- 0 Points ----- Marginal
  - **+50.1 to +1000 mOhms**----- 0 Points ----- Unstable
  - **>+1000 mOhms**----- 0 Points ----- Open Failure
- **Thermal**
  - **<= +5.0 mOhms**----- 32 Points ----- Stable
  - **+5.1 to +10.0 mOhms**----- 0 Points ----- Minor
  - **+10.1 to +15.0 mOhms**----- 0 Points ----- Acceptable
  - **+15.1 to +50.0 mOhms**----- 0 Points ----- Marginal
  - **+50.1 to +1000 mOhms**----- 0 Points ----- Unstable
  - **>+1000 mOhms**----- 0 Points ----- Open Failure
- **Humidity**
  - **<= +5.0 mOhms**----- 32 Points ----- Stable
  - **+5.1 to +10.0 mOhms**----- 0 Points ----- Minor
  - **+10.1 to +15.0 mOhms**----- 0 Points ----- Acceptable
  - **+15.1 to +50.0 mOhms**----- 0 Points ----- Marginal
  - **+50.1 to +1000 mOhms**----- 0 Points ----- Unstable
  - **>+1000 mOhms**----- 0 Points ----- Open Failure

**RESULTS Continued****LLCR Durability (1024 signal and 128 ground LLCR test points)****NVBM-DP-16-RA-S-2-B-A/NVBF-DP-16-VT-S-2-B-A****Signal pin**

- **Initial**----- 31.32 mOhms Max
- **Durability, 100 Cycles**
  - **<= +5.0 mOhms**----- 1024 Points ----- Stable
  - **+5.1 to +10.0 mOhms**-----0 Points ----- Minor
  - **+10.1 to +15.0 mOhms** -----0 Points ----- Acceptable
  - **+15.1 to +50.0 mOhms** -----0 Points ----- Marginal
  - **+50.1 to +1000 mOhms**-----0 Points ----- Unstable
  - **>+1000 mOhms**-----0 Points ----- Open Failure
- **Thermal**
  - **<= +5.0 mOhms**----- 1024 Points ----- Stable
  - **+5.1 to +10.0 mOhms**-----0 Points ----- Minor
  - **+10.1 to +15.0 mOhms** -----0 Points ----- Acceptable
  - **+15.1 to +50.0 mOhms** -----0 Points ----- Marginal
  - **+50.1 to +1000 mOhms**-----0 Points ----- Unstable
  - **>+1000 mOhms**-----0 Points ----- Open Failure
- **Humidity**
  - **<= +5.0 mOhms**----- 1023 Points ----- Stable
  - **+5.1 to +10.0 mOhms**-----1 Points ----- Minor
  - **+10.1 to +15.0 mOhms** -----0 Points ----- Acceptable
  - **+15.1 to +50.0 mOhms** -----0 Points ----- Marginal
  - **+50.1 to +1000 mOhms**-----0 Points ----- Unstable
  - **>+1000 mOhms**-----0 Points ----- Open Failure

**Ground pin**

- **Initial**-----9.73 mOhms Max
- **Durability, 100 Cycles**
  - **<= +5.0 mOhms**----- 128 Points ----- Stable
  - **+5.1 to +10.0 mOhms**-----0 Points ----- Minor
  - **+10.1 to +15.0 mOhms** -----0 Points ----- Acceptable
  - **+15.1 to +50.0 mOhms** -----0 Points ----- Marginal
  - **+50.1 to +1000 mOhms**-----0 Points ----- Unstable
  - **>+1000 mOhms**-----0 Points ----- Open Failure
- **Thermal**
  - **<= +5.0 mOhms**----- 128 Points ----- Stable
  - **+5.1 to +10.0 mOhms**-----0 Points ----- Minor
  - **+10.1 to +15.0 mOhms** -----0 Points ----- Acceptable
  - **+15.1 to +50.0 mOhms** -----0 Points ----- Marginal
  - **+50.1 to +1000 mOhms**-----0 Points ----- Unstable
  - **>+1000 mOhms**-----0 Points ----- Open Failure
- **Humidity**
  - **<= +5.0 mOhms**----- 128 Points ----- Stable
  - **+5.1 to +10.0 mOhms**-----0 Points ----- Minor
  - **+10.1 to +15.0 mOhms** -----0 Points ----- Acceptable
  - **+15.1 to +50.0 mOhms** -----0 Points ----- Marginal
  - **+50.1 to +1000 mOhms**-----0 Points ----- Unstable
  - **>+1000 mOhms**-----0 Points ----- Open Failure

**RESULTS Continued****LLCR Shock & Vibration (256 signal and 32 ground LLCR test points)****Signal pin**

- **Initial** ----- 28.20 mOhms Max
- **Shock & Vibration**
  - **<= +5.0 mOhms**-----247 Points ----- Stable
  - **+5.1 to +10.0 mOhms** -----9 Points ----- Minor
  - **+10.1 to +15.0 mOhms** -----0 Points ----- Acceptable
  - **+15.1 to +50.0 mOhms** -----0 Points ----- Marginal
  - **+50.1 to +1000 mOhms**-----0 Points ----- Unstable
  - **>+1000 mOhms**-----0 Points ----- Open Failure

**Ground pin**

- **Initial** -----6.96 mOhms Max
- **Shock & Vibration**
  - **<= +5.0 mOhms**-----32 Points ----- Stable
  - **+5.1 to +10.0 mOhms** -----0 Points ----- Minor
  - **+10.1 to +15.0 mOhms** -----0 Points ----- Acceptable
  - **+15.1 to +50.0 mOhms** -----0 Points ----- Marginal
  - **+50.1 to +1000 mOhms**-----0 Points ----- Unstable
  - **>+1000 mOhms**-----0 Points ----- Open Failure

**Mechanical Shock & Random Vibration:**

- **Shock**
  - **No Damage**----- Pass
  - **50 Nanoseconds** ----- Pass
- **Vibration**
  - **No Damage**----- Pass
  - **50 Nanoseconds** ----- Pass

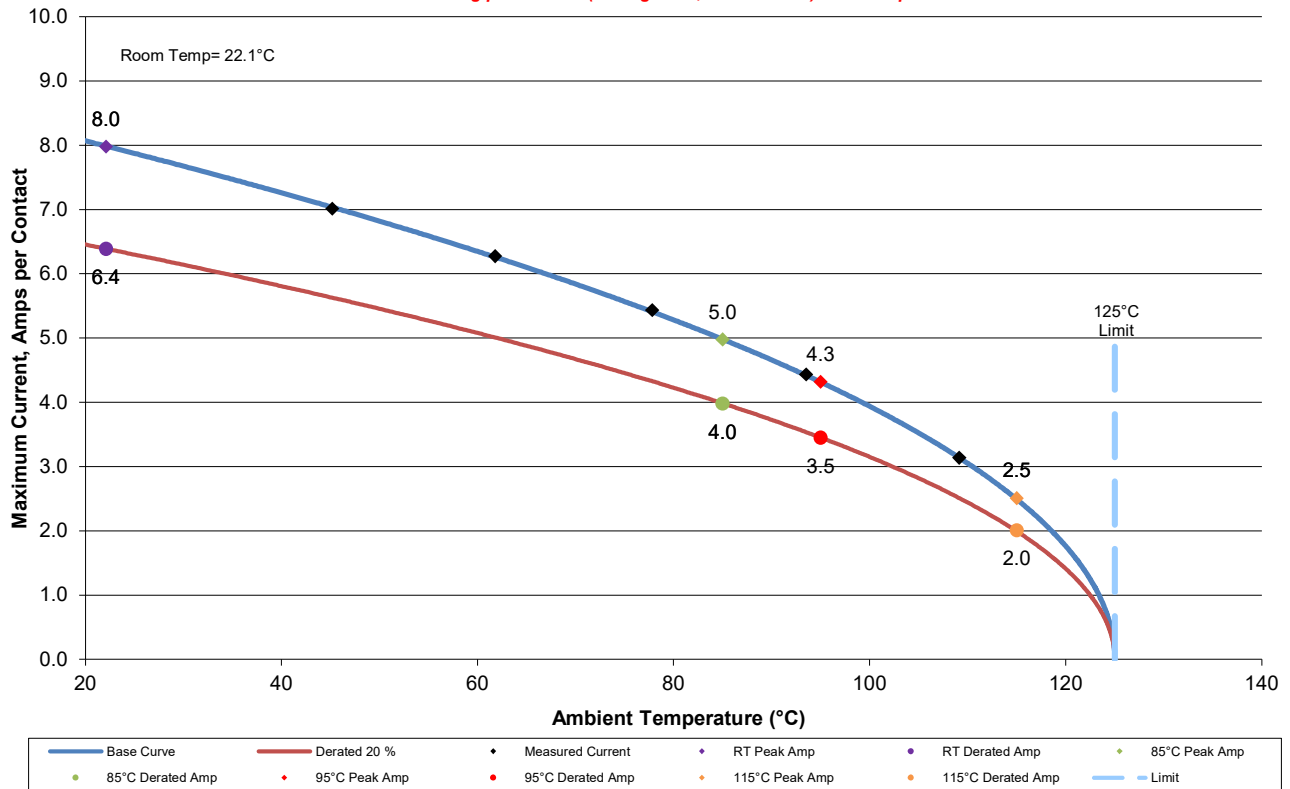
### DATA SUMMARIES

#### TEMPERATURE RISE (Current Carrying Capacity, CCC):

- 1) High quality thermocouples whose temperature slopes track one another were used for temperature monitoring.
- 2) The thermocouples were placed at a location to sense the maximum temperature generated during testing.
- 3) Temperature readings recorded are those for which three successive readings, 15 minutes apart, differ less than 1° C (computer controlled data acquisition).
- 4) Adjacent contacts were powered:
  - a. Linear configuration with 1 adjacent conductors/contacts powered

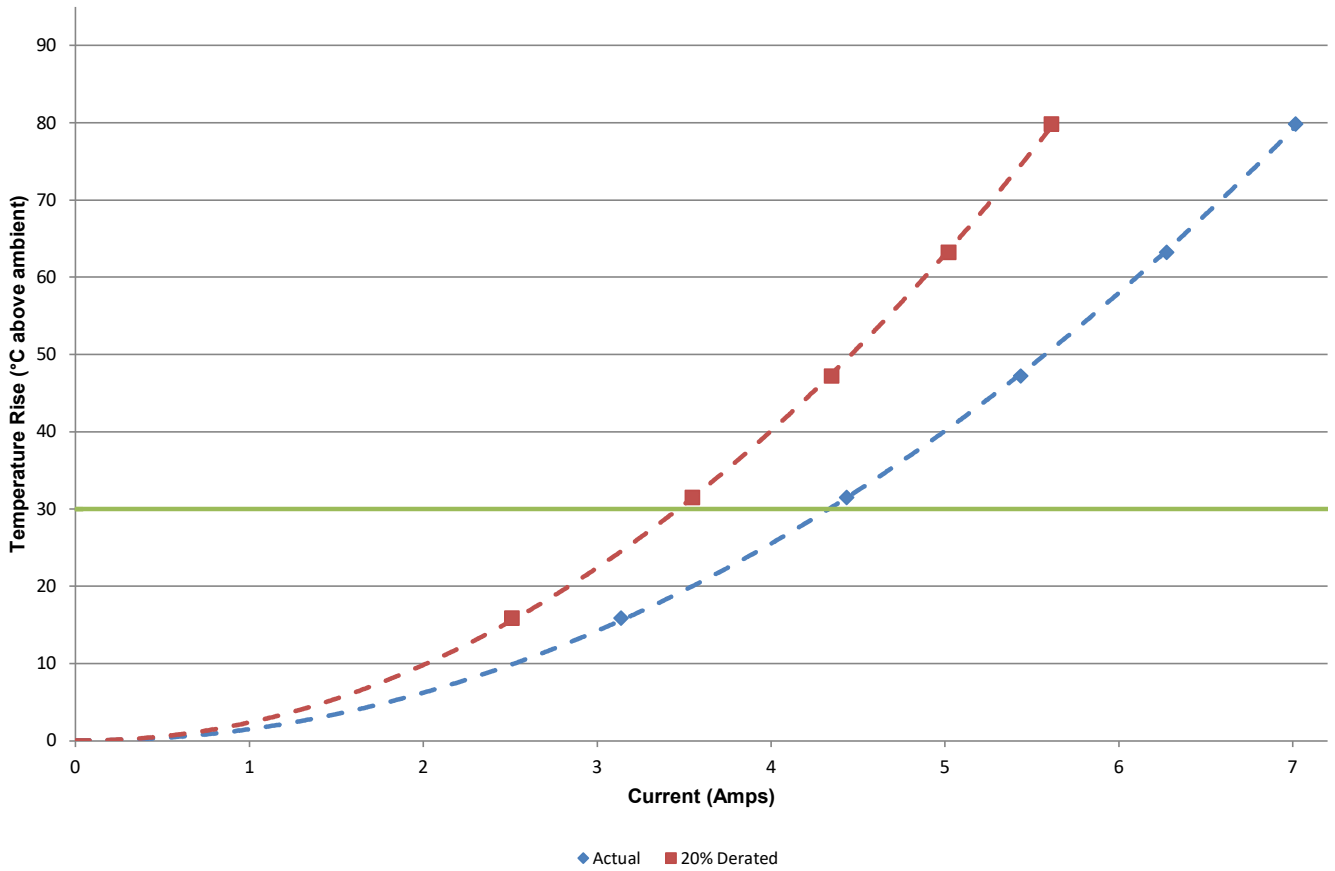
**CR-1144501**  
**1 (1x1) Contact in Series**  
**Part Numbers: NVBM-DP-04-RA-S-2-B-C/NVBF-DP-04-VT-S-2-B-C**

*Current Rating per Contact (30 Deg. Rise, 20% Derated) = 3.5 Amps*



### DATA SUMMARIES Continued

CR-1144501  
1 (1x1) Contacts in Series  
Part Numbers: NVBM-DP-04-RA-S-2-B-C/NVBF-DP-04-VT-S-2-B-C

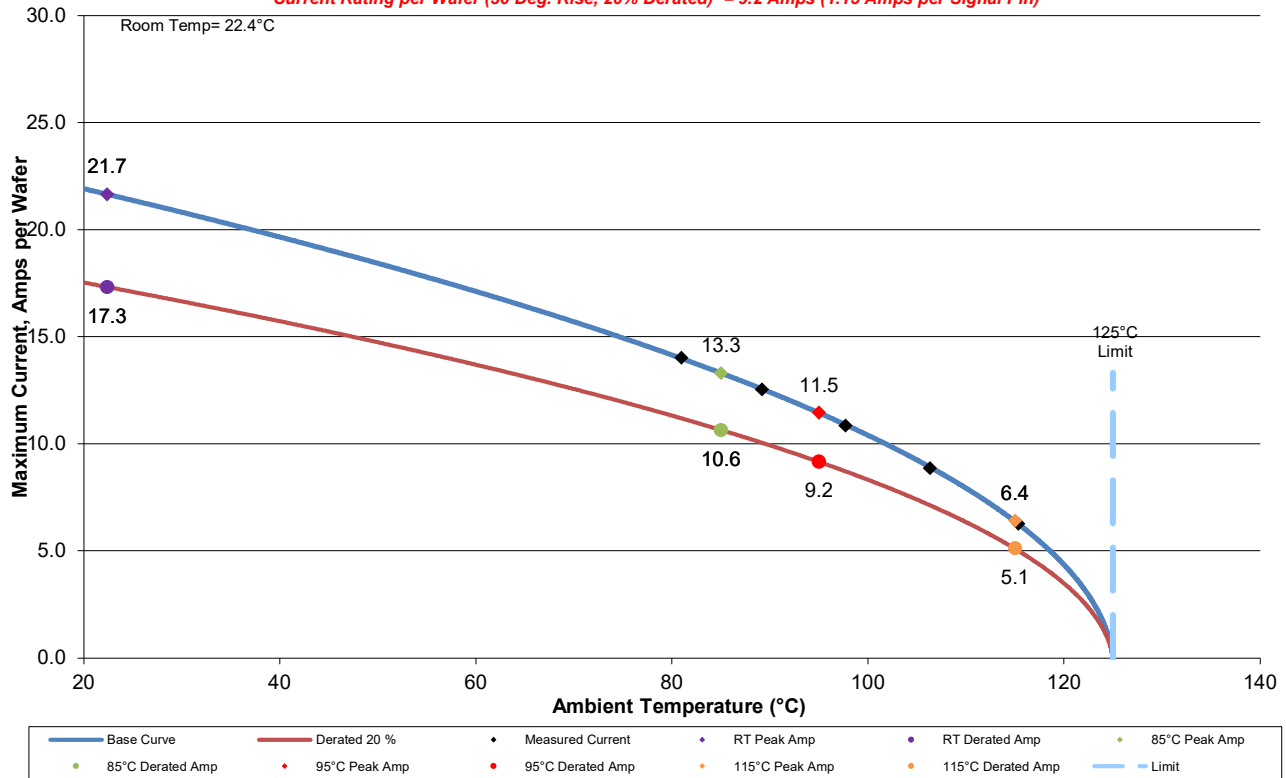


### DATA SUMMARIES Continued

b. Linear configuration with 8 adjacent conductors/contacts powered

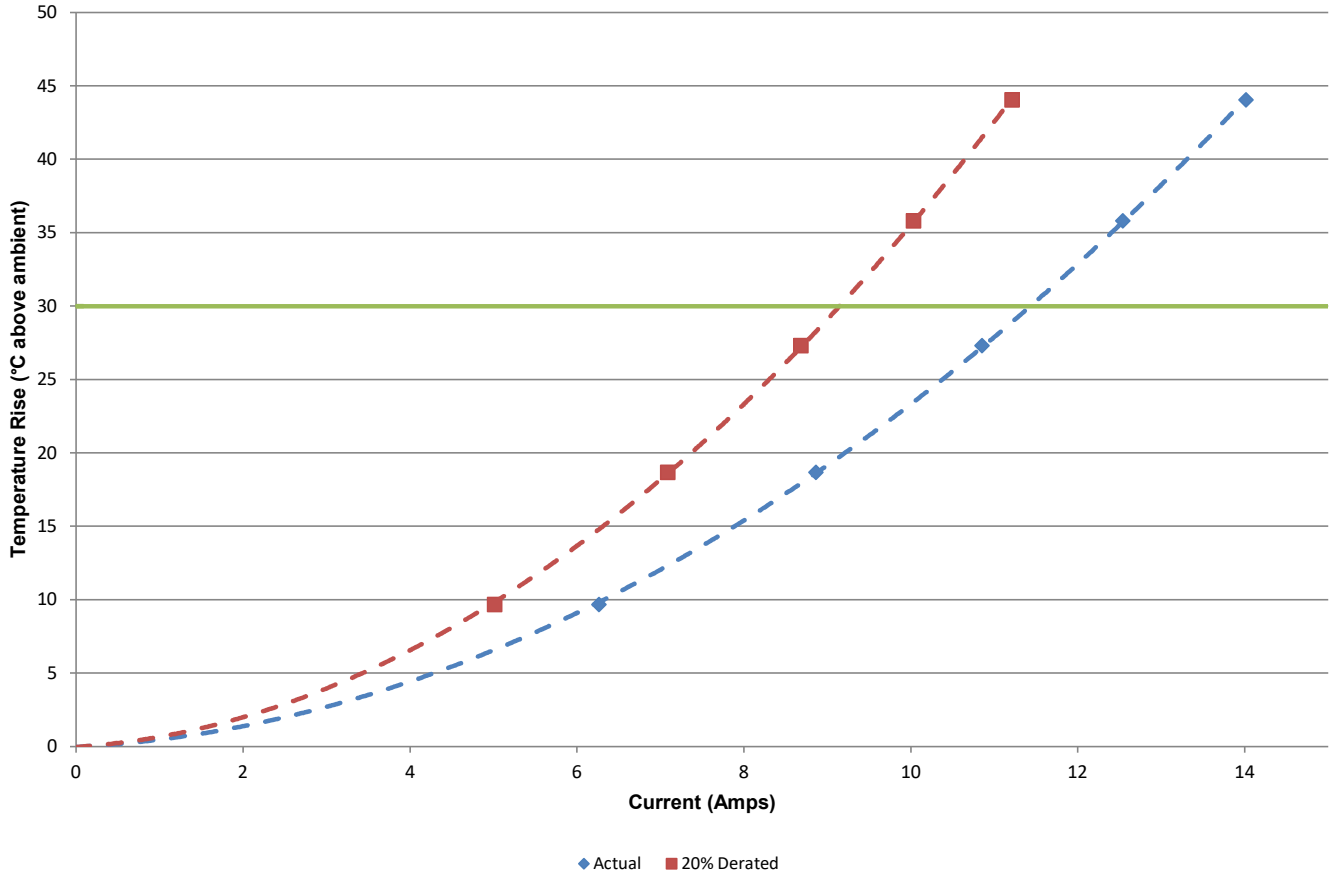
**CR-1144501**  
**8 (1x8) Contacts in Series**  
 (All Signal Pins Combined Carry Supply while all Grounds on that Wafer Carry Return)  
 Part Numbers: NVBM-DP-04-RA-S-2-B-C/NVBF-DP-04-VT-S-2-B-C

*Current Rating per Wafer (30 Deg. Rise, 20% Derated) = 9.2 Amps (1.15 Amps per Signal Pin)*



### DATA SUMMARIES Continued

CR-1144501  
8 (1x8) Contacts in Series  
Part Numbers: NVBM-DP-04-RA-S-2-B-C/NVBF-DP-04-VT-S-2-B-C



### DATA SUMMARIES Continued

**MATING/UNMATING:**  
**Thermal Aging Group**

	Initial				After Thermals			
	Mating		Unmating		Mating		Unmating	
	Newton's	Force (Lbs)	Newton's	Force (Lbs)	Newton's	Force (Lbs)	Newton's	Force (Lbs)
Minimum	11.88	2.67	9.79	2.20	7.12	1.60	5.74	1.29
Maximum	14.77	3.32	11.92	2.68	8.32	1.87	6.49	1.46
<b>Average</b>	13.73	<b>3.09</b>	10.89	<b>2.45</b>	7.69	<b>1.73</b>	6.12	<b>1.38</b>
St Dev	0.91	0.20	0.76	0.17	0.42	0.09	0.29	0.07
Count	8	8	8	8	8	8	8	8

**Mating/Unmating Durability Group (NVBM-DP-04-RA-S-2-B-C/NVBF-DP-04-VT-S-2-B-C)**

	Initial				25 Cycles			
	Mating		Unmating		Mating		Unmating	
	Newton's	Force (Lbs)	Newton's	Force (Lbs)	Newton's	Force (Lbs)	Newton's	Force (Lbs)
Minimum	11.61	2.61	8.81	1.98	14.54	3.27	10.59	2.38
Maximum	14.32	3.22	10.90	2.45	15.97	3.59	11.88	2.67
<b>Average</b>	13.35	<b>3.00</b>	9.86	<b>2.22</b>	15.50	<b>3.48</b>	11.54	<b>2.60</b>
St Dev	0.82	0.18	0.69	0.15	0.50	0.11	0.44	0.10
Count	8	8	8	8	8	8	8	8

	50 Cycles				75 Cycles			
	Mating		Unmating		Mating		Unmating	
	Newton's	Force (Lbs)	Newton's	Force (Lbs)	Newton's	Force (Lbs)	Newton's	Force (Lbs)
Minimum	14.23	3.20	11.08	2.49	14.23	3.20	11.34	2.55
Maximum	16.10	3.62	12.54	2.82	15.97	3.59	13.21	2.97
<b>Average</b>	15.47	<b>3.48</b>	12.02	<b>2.70</b>	15.41	<b>3.46</b>	12.52	<b>2.81</b>
St Dev	0.65	0.15	0.45	0.10	0.64	0.14	0.59	0.13
Count	8	8	8	8	8	8	8	8

	100 Cycles				After Humidity			
	Mating		Unmating		Mating		Unmating	
	Newton's	Force (Lbs)	Newton's	Force (Lbs)	Newton's	Force (Lbs)	Newton's	Force (Lbs)
Minimum	14.19	3.19	11.65	2.62	7.65	1.72	6.45	1.45
Maximum	16.28	3.66	13.39	3.01	9.12	2.05	7.92	1.78
<b>Average</b>	15.41	<b>3.47</b>	12.81	<b>2.88</b>	8.42	<b>1.89</b>	7.13	<b>1.60</b>
St Dev	0.68	0.15	0.60	0.13	0.52	0.12	0.50	0.11
Count	8	8	8	8	8	8	8	8

**DATA SUMMARIES Continued****Mating/Unmating Durability Group (NVBM-DP-16-RA-S-2-B-A/NVBF-DP-16-VT-S-2-B-A)**

	Initial				25 Cycles			
	Mating		Unmating		Mating		Unmating	
	Newton's	Force (Lbs)	Newton's	Force (Lbs)	Newton's	Force (Lbs)	Newton's	Force (Lbs)
Minimum	39.63	8.91	32.92	7.40	47.77	10.74	39.59	8.90
Maximum	47.02	10.57	38.61	8.68	56.31	12.66	46.93	10.55
<b>Average</b>	44.06	<b>9.91</b>	36.06	<b>8.11</b>	53.41	<b>12.01</b>	43.02	<b>9.67</b>
St Dev	2.43	0.55	1.80	0.41	3.04	0.68	2.28	0.51
Count	8	8	8	8	8	8	8	8
	50 Cycles				75 Cycles			
	Mating		Unmating		Mating		Unmating	
	Newton's	Force (Lbs)	Newton's	Force (Lbs)	Newton's	Force (Lbs)	Newton's	Force (Lbs)
Minimum	49.91	11.22	41.46	9.32	50.93	11.45	42.57	9.57
Maximum	57.38	12.90	48.62	10.93	59.11	13.29	49.51	11.13
<b>Average</b>	54.55	<b>12.26</b>	45.12	<b>10.15</b>	55.82	<b>12.55</b>	46.62	<b>10.48</b>
St Dev	2.80	0.63	2.18	0.49	2.84	0.64	2.26	0.51
Count	8	8	8	8	8	8	8	8
	100 Cycles				After Humidity			
	Mating		Unmating		Mating		Unmating	
	Newton's	Force (Lbs)	Newton's	Force (Lbs)	Newton's	Force (Lbs)	Newton's	Force (Lbs)
Minimum	52.44	11.79	43.90	9.87	35.09	7.89	29.85	6.71
Maximum	60.80	13.67	50.71	11.40	38.83	8.73	32.69	7.35
<b>Average</b>	57.42	<b>12.91</b>	47.94	<b>10.78</b>	37.32	<b>8.39</b>	31.28	<b>7.03</b>
St Dev	2.84	0.64	2.22	0.50	1.63	0.37	0.97	0.22
Count	8	8	8	8	8	8	8	8

**DATA SUMMARIES Continued**

**NORMAL FORCE (FOR CONTACTS TESTED OUTSIDE THE HOUSING):**

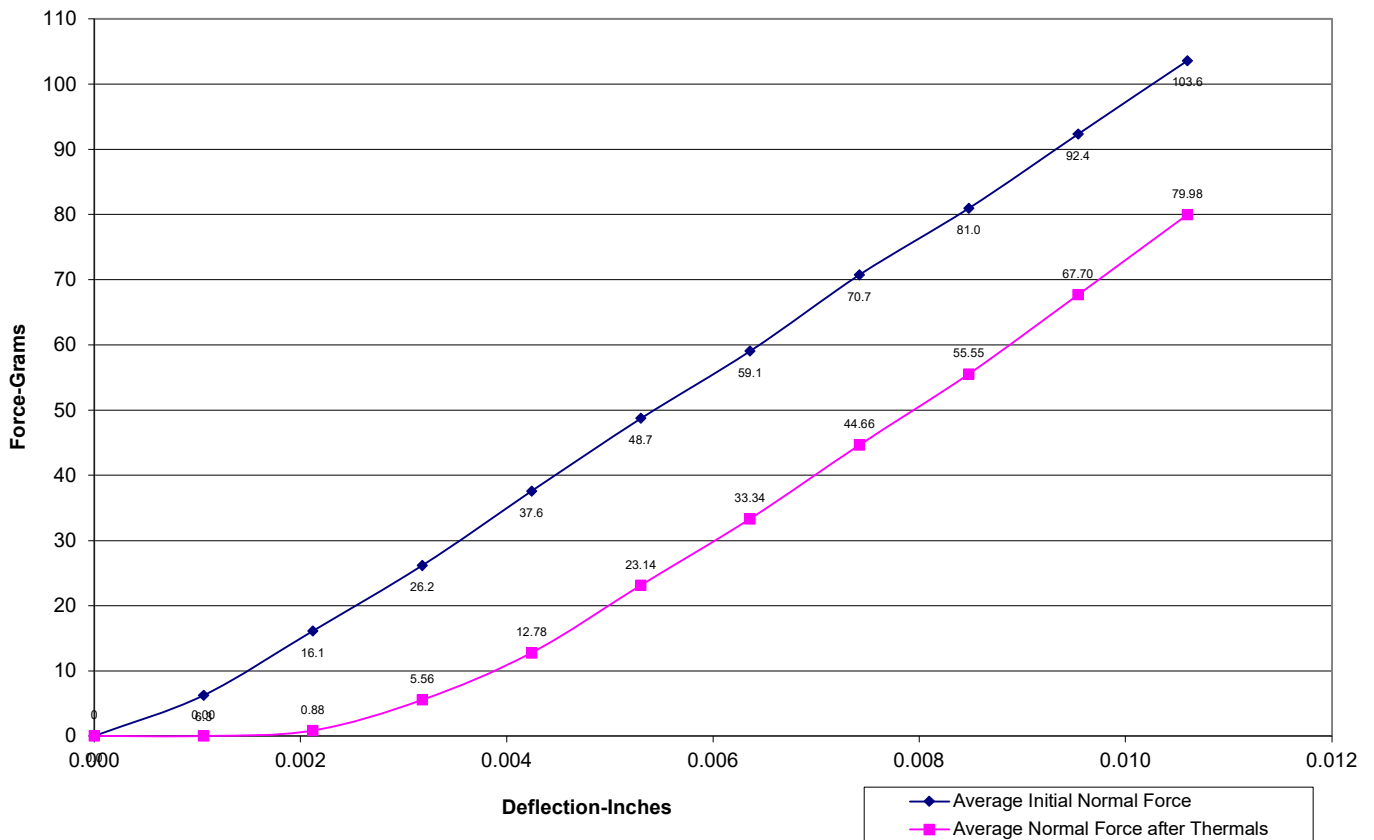
- 1) Calibrated force gauges are used along with computer-controlled positioning equipment.
- 2) Typically, 8-10 readings are taken, and the averages reported.

**NVBM Signal pin SH168-B**

Initial	Deflections in inches Forces in Grams										
	<b>0.0011</b>	<b>0.0021</b>	<b>0.0032</b>	<b>0.0042</b>	<b>0.0053</b>	<b>0.0064</b>	<b>0.0074</b>	<b>0.0085</b>	<b>0.0095</b>	<b>0.0106</b>	<i>SET</i>
<b>Averages</b>	6.26	16.13	26.16	37.56	48.74	59.06	70.74	80.96	92.35	103.59	0.0002
<b>Min</b>	3.00	9.60	18.10	27.90	37.30	47.60	58.40	67.40	77.50	87.80	0.0000
<b>Max</b>	10.70	23.10	34.70	48.00	60.60	72.10	85.10	95.80	108.30	120.60	0.0004
<b>St. Dev</b>	2.511	4.258	5.231	6.601	7.787	8.269	9.176	10.001	10.981	11.608	0.0001
<b>Count</b>	8	8	8	8	8	8	8	8	8	8	8

After Thermals	Deflections in inches Forces in Grams										
	<b>0.0011</b>	<b>0.0021</b>	<b>0.0032</b>	<b>0.0042</b>	<b>0.0053</b>	<b>0.0064</b>	<b>0.0074</b>	<b>0.0085</b>	<b>0.0095</b>	<b>0.0106</b>	<i>SET</i>
<b>Averages</b>	0.00	0.88	5.56	12.78	23.14	33.34	44.66	55.55	67.70	79.98	0.0025
<b>Min</b>	0.00	0.00	0.00	0.00	5.90	17.10	28.80	40.00	51.40	60.90	0.0016
<b>Max</b>	0.00	2.00	11.40	23.90	36.20	45.90	55.90	67.00	79.10	91.00	0.0046
<b>St. Dev</b>	0.000	0.919	4.362	8.763	10.621	10.634	10.455	10.780	11.474	12.254	0.0011
<b>Count</b>	8	8	8	8	8	8	8	8	8	8	8

**Normal Force - Average Initial vs Average Thermal (SH168-B)**

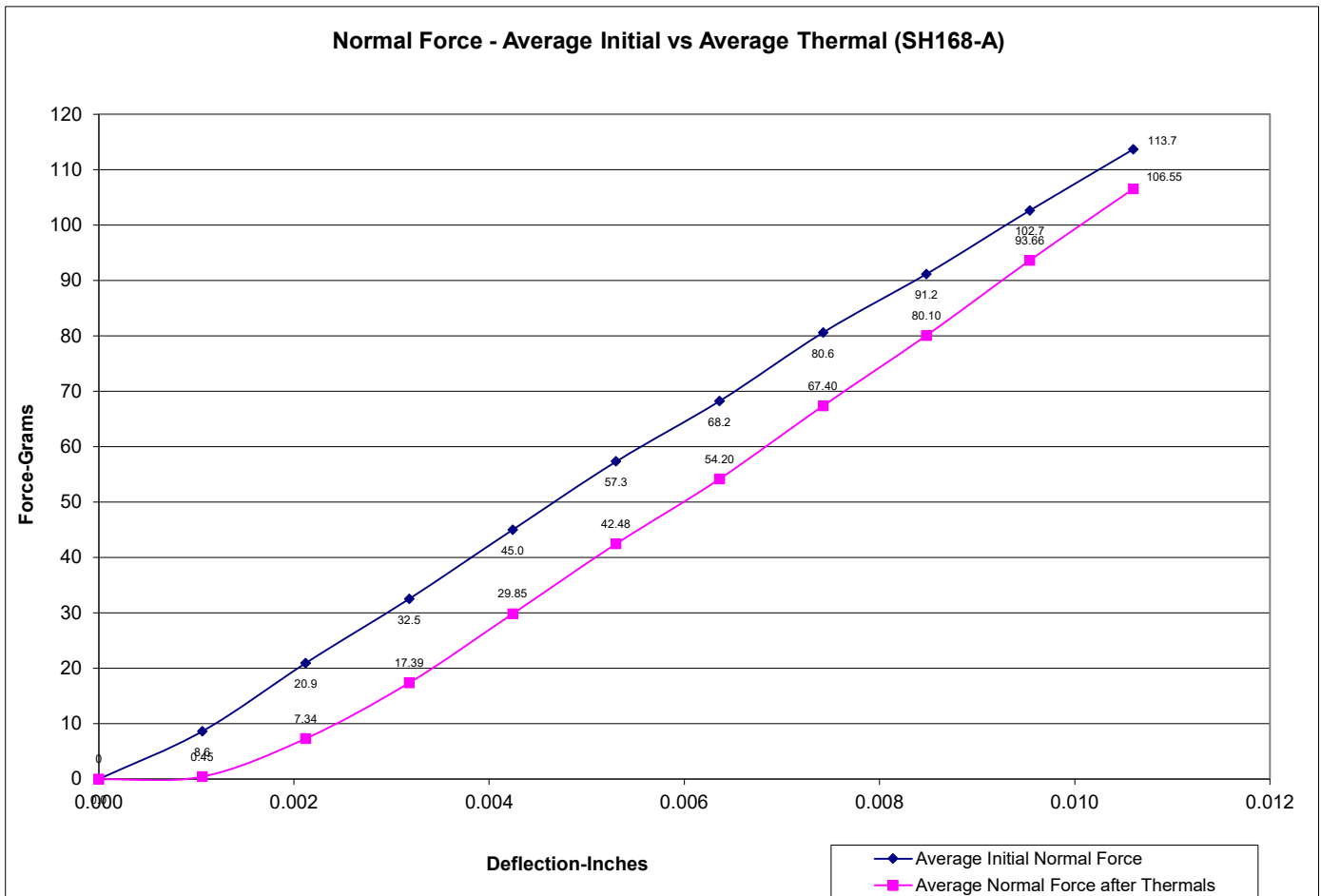


### DATA SUMMARIES Continued

#### NVBM Signal pin SH168-A

Initial	Deflections in inches Forces in Grams										
	<u>0.0011</u>	<u>0.0021</u>	<u>0.0032</u>	<u>0.0042</u>	<u>0.0053</u>	<u>0.0064</u>	<u>0.0074</u>	<u>0.0085</u>	<u>0.0095</u>	<u>0.0106</u>	<i>SET</i>
<b>Averages</b>	8.61	20.94	32.53	45.01	57.34	68.24	80.61	91.19	102.65	113.69	0.0004
<b>Min</b>	6.40	14.90	27.40	40.60	53.20	63.40	74.30	84.30	95.00	106.00	0.0001
<b>Max</b>	11.50	24.80	37.00	49.80	63.00	73.60	86.30	97.40	109.20	120.20	0.0006
<b>St. Dev</b>	2.084	3.405	3.523	3.745	4.263	4.325	4.799	5.456	5.668	5.698	0.0002
<b>Count</b>	8	8	8	8	8	8	8	8	8	8	8

After Thermals	Deflections in inches Forces in Grams										
	<u>0.0011</u>	<u>0.0021</u>	<u>0.0032</u>	<u>0.0042</u>	<u>0.0053</u>	<u>0.0064</u>	<u>0.0074</u>	<u>0.0085</u>	<u>0.0095</u>	<u>0.0106</u>	<i>SET</i>
<b>Averages</b>	0.45	7.34	17.39	29.85	42.48	54.20	67.40	80.10	93.66	106.55	0.0013
<b>Min</b>	-0.10	0.00	7.40	20.10	32.70	44.30	57.30	71.20	84.50	97.00	0.0007
<b>Max</b>	1.70	12.60	23.90	37.10	49.70	61.80	75.00	89.00	104.00	116.60	0.0024
<b>St. Dev</b>	0.621	4.923	6.316	6.427	6.162	6.353	6.708	6.912	7.457	7.605	0.0006
<b>Count</b>	8	8	8	8	8	8	8	8	8	8	8



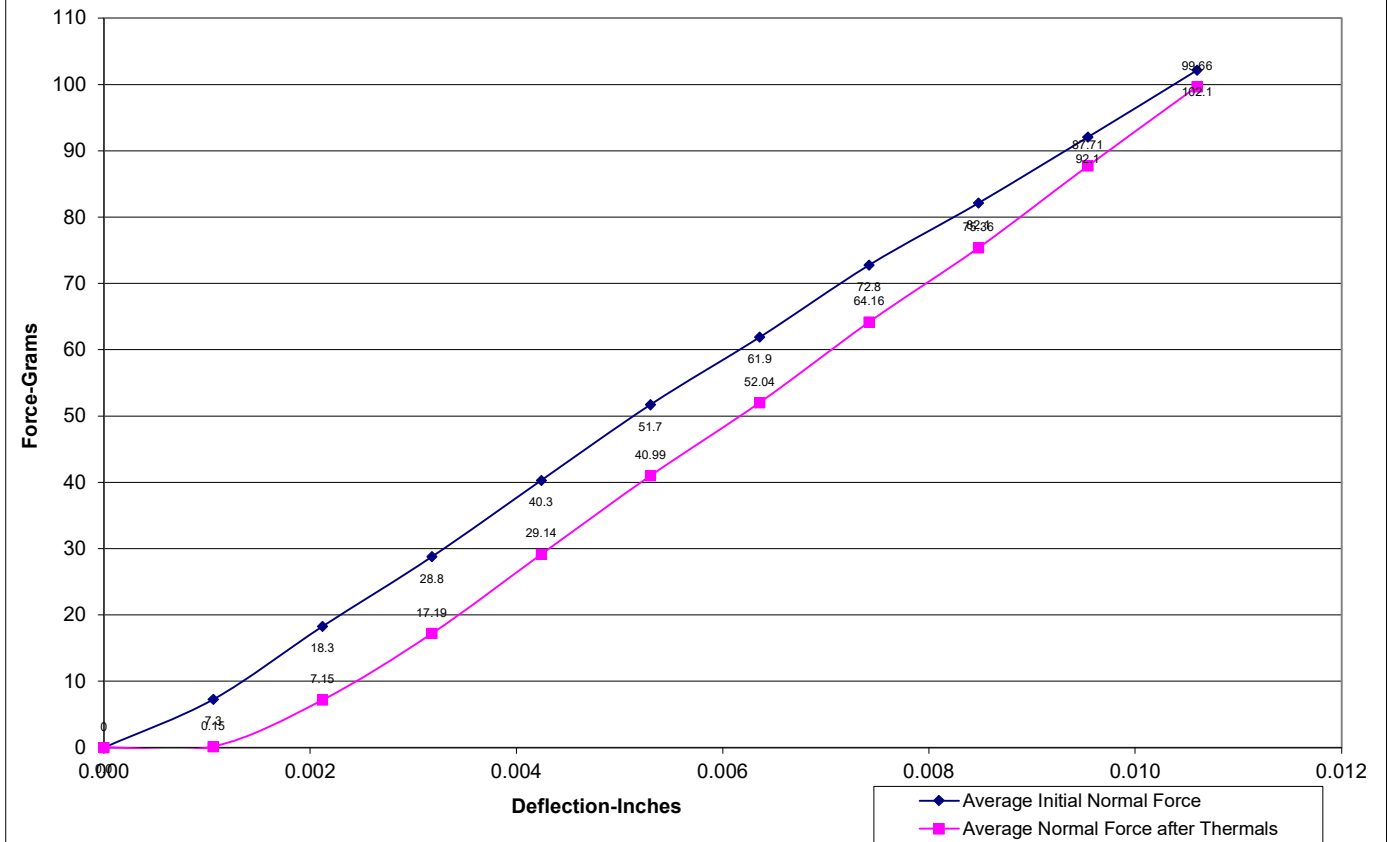
**DATA SUMMARIES Continued**

**NVBM Signal pin SH159-B**

Initial	Deflections in inches Forces in Grams										
	<u>0.0011</u>	<u>0.0021</u>	<u>0.0032</u>	<u>0.0042</u>	<u>0.0053</u>	<u>0.0064</u>	<u>0.0074</u>	<u>0.0085</u>	<u>0.0095</u>	<u>0.0106</u>	<i>SET</i>
<b>Averages</b>	7.29	18.26	28.78	40.30	51.71	61.91	72.76	82.13	92.08	102.14	0.0004
<b>Min</b>	6.10	16.10	26.80	37.40	47.70	56.50	65.50	72.80	79.50	87.00	0.0001
<b>Max</b>	9.10	21.60	31.30	43.90	56.40	67.90	80.60	92.00	105.10	117.80	0.0007
<b>St. Dev</b>	1.164	1.971	1.912	2.465	3.125	4.106	5.539	7.200	9.426	11.052	0.0002
<b>Count</b>	8	8	8	8	8	8	8	8	8	8	8

After Thermals	Deflections in inches Forces in Grams										
	<u>0.0011</u>	<u>0.0021</u>	<u>0.0032</u>	<u>0.0042</u>	<u>0.0053</u>	<u>0.0064</u>	<u>0.0074</u>	<u>0.0085</u>	<u>0.0095</u>	<u>0.0106</u>	<i>SET</i>
<b>Averages</b>	0.15	7.15	17.19	29.14	40.99	52.04	64.16	75.36	87.71	99.66	0.0013
<b>Min</b>	-0.10	4.30	14.40	26.50	37.40	46.60	57.10	67.40	79.00	90.00	0.0008
<b>Max</b>	0.70	10.10	20.90	32.80	44.90	56.00	68.40	80.00	92.70	104.80	0.0018
<b>St. Dev</b>	0.288	2.245	2.325	2.284	2.497	2.946	3.478	3.908	4.296	4.570	0.0003
<b>Count</b>	8	8	8	8	8	8	8	8	8	8	8

**Normal Force - Average Initial vs Average Thermal (SH159-B)**



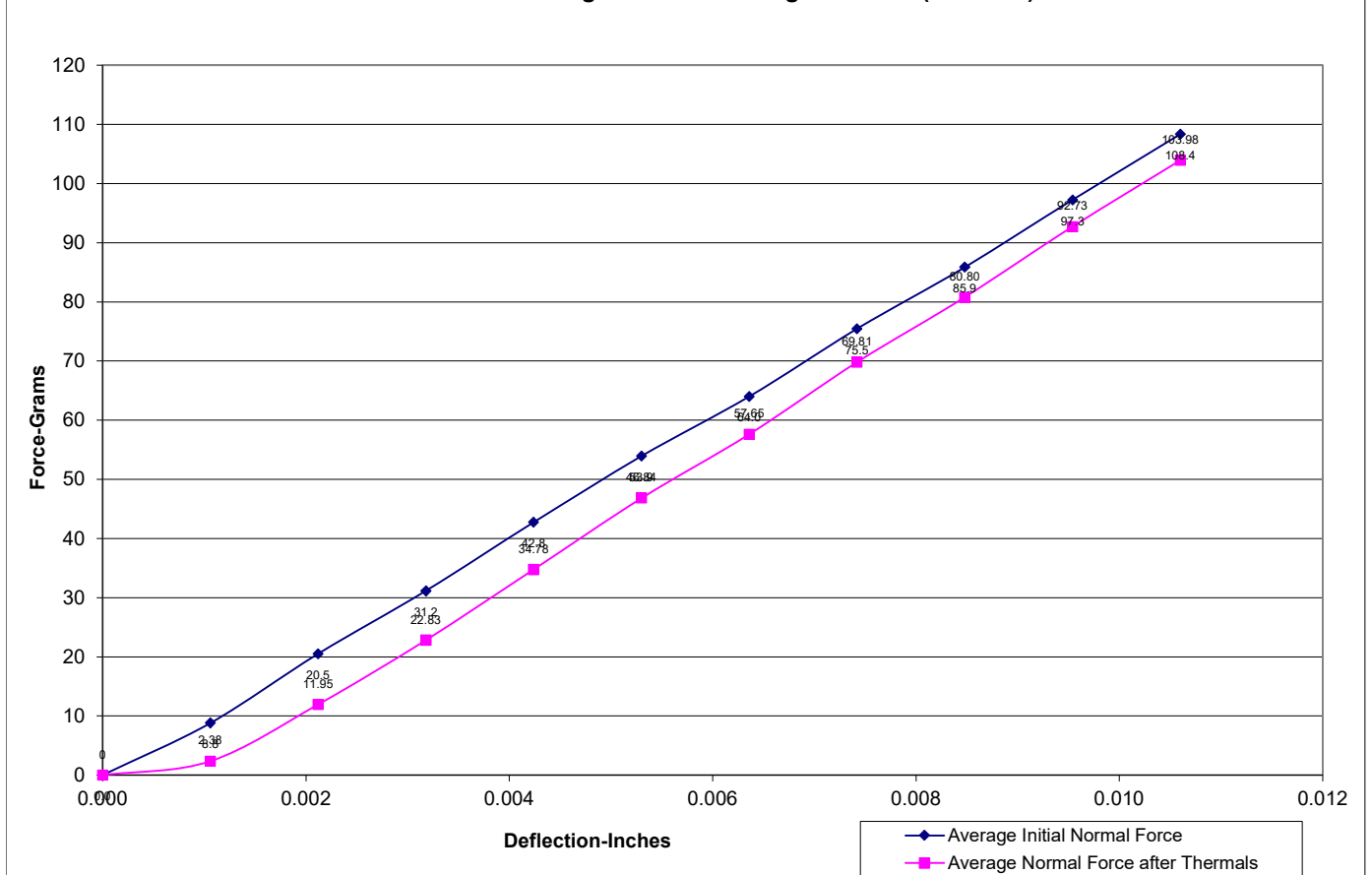
**DATA SUMMARIES Continued**

**NVBM Signal pin SH159-A**

Initial	Deflections in inches Forces in Grams										
	<u>0.0011</u>	<u>0.0021</u>	<u>0.0032</u>	<u>0.0042</u>	<u>0.0053</u>	<u>0.0064</u>	<u>0.0074</u>	<u>0.0085</u>	<u>0.0095</u>	<u>0.0106</u>	<i>SET</i>
<b>Averages</b>	8.83	20.52	31.15	42.77	53.93	64.02	75.45	85.87	97.25	108.37	0.0003
<b>Min</b>	7.70	17.40	25.60	34.60	43.40	50.90	59.90	67.70	76.00	84.50	0.0001
<b>Max</b>	10.70	23.10	34.70	48.00	60.60	72.10	85.10	95.80	108.40	120.60	0.0005
<b>St. Dev</b>	1.138	2.124	3.406	5.033	6.582	8.102	9.610	11.012	12.639	14.241	0.0002
<b>Count</b>	6	6	6	6	6	6	6	6	6	6	6

After Thermals	Deflections in inches Forces in Grams										
	<u>0.0011</u>	<u>0.0021</u>	<u>0.0032</u>	<u>0.0042</u>	<u>0.0053</u>	<u>0.0064</u>	<u>0.0074</u>	<u>0.0085</u>	<u>0.0095</u>	<u>0.0106</u>	<i>SET</i>
<b>Averages</b>	2.38	11.95	22.83	34.78	46.84	57.65	69.81	80.80	92.73	103.98	0.0009
<b>Min</b>	0.50	7.90	18.60	31.30	43.20	53.30	64.00	73.30	83.10	93.30	0.0006
<b>Max</b>	5.10	16.50	27.20	39.20	50.70	60.60	73.30	85.00	98.20	111.50	0.0012
<b>St. Dev</b>	1.448	2.834	2.798	2.721	2.465	2.428	3.150	3.827	4.726	5.620	0.0002
<b>Count</b>	8	8	8	8	8	8	8	8	8	8	8

**Normal Force - Average Initial vs Average Thermal (SH159-A)**



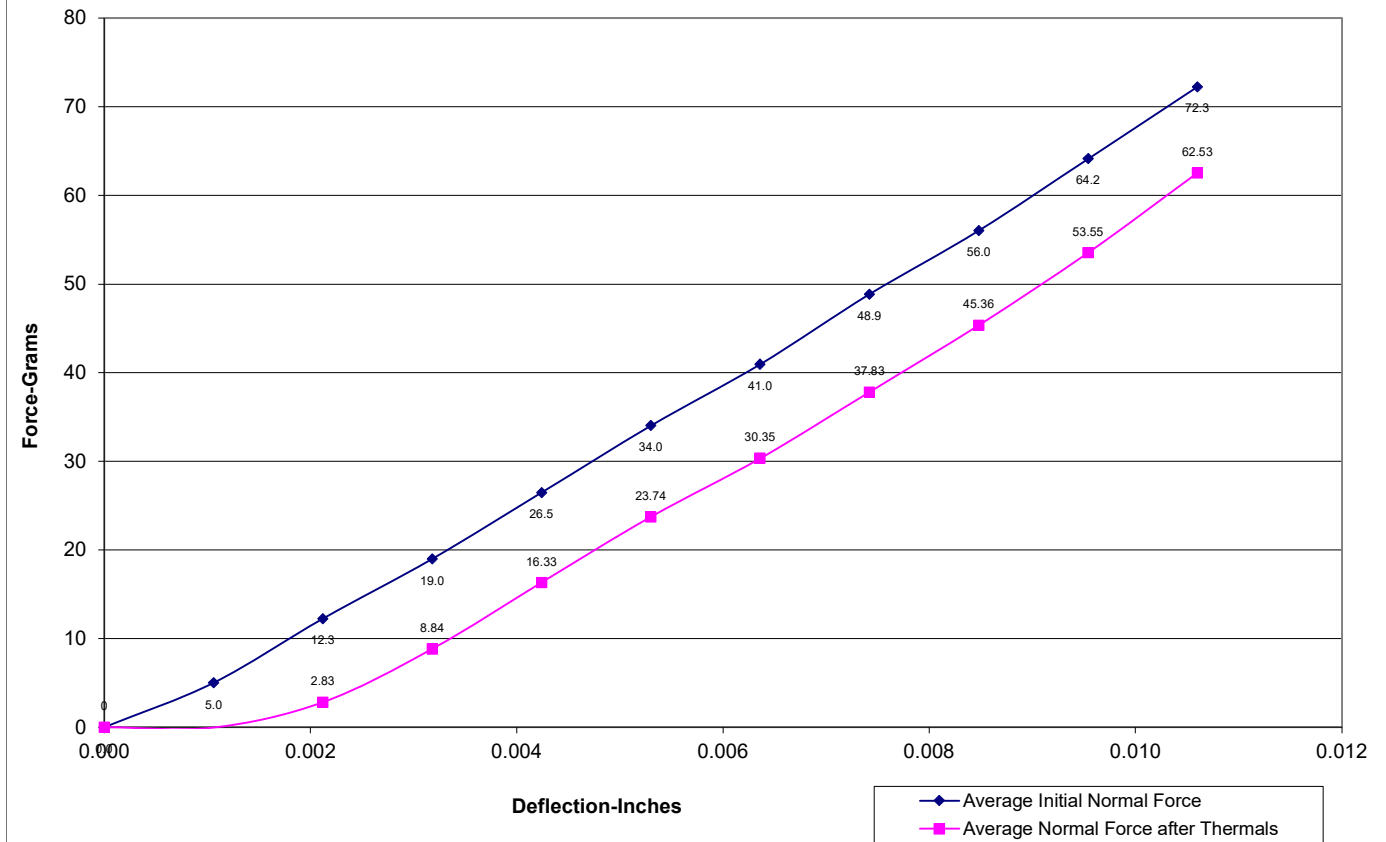
**DATA SUMMARIES Continued**

**NVBF Signal pin SH164-A**

Initial	Deflections in inches Forces in Grams										
	<u>0.0011</u>	<u>0.0021</u>	<u>0.0032</u>	<u>0.0042</u>	<u>0.0053</u>	<u>0.0064</u>	<u>0.0074</u>	<u>0.0085</u>	<u>0.0095</u>	<u>0.0106</u>	<i>SET</i>
<b>Averages</b>	5.01	12.26	19.00	26.48	34.03	40.96	48.85	56.04	64.15	72.25	0.0004
<b>Min</b>	4.00	11.00	17.70	24.90	31.80	38.00	44.70	50.70	57.40	64.30	0.0003
<b>Max</b>	7.00	14.50	20.70	28.10	36.10	44.20	55.10	65.30	77.20	87.90	0.0004
<b>St. Dev</b>	1.093	1.256	1.061	1.108	1.402	2.177	3.873	5.526	7.464	9.240	0.0001
<b>Count</b>	8	8	8	8	8	8	8	8	8	8	8

After Thermals	Deflections in inches Forces in Grams										
	<u>0.0011</u>	<u>0.0021</u>	<u>0.0032</u>	<u>0.0042</u>	<u>0.0053</u>	<u>0.0064</u>	<u>0.0074</u>	<u>0.0085</u>	<u>0.0095</u>	<u>0.0106</u>	<i>SET</i>
<b>Averages</b>	-0.03	2.83	8.84	16.33	23.74	30.35	37.83	45.36	53.55	62.53	0.0017
<b>Min</b>	-0.10	0.60	5.40	12.70	19.90	26.60	33.70	40.50	47.90	55.30	0.0014
<b>Max</b>	0.00	5.30	12.00	19.40	27.10	34.00	43.40	54.80	66.70	79.30	0.0021
<b>St. Dev</b>	0.046	1.659	2.492	2.475	2.644	2.610	3.022	4.286	5.973	8.058	0.0002
<b>Count</b>	8	8	8	8	8	8	8	8	8	8	8

**Normal Force - Average Initial vs Average Thermal (SH164-A)(Signal)**

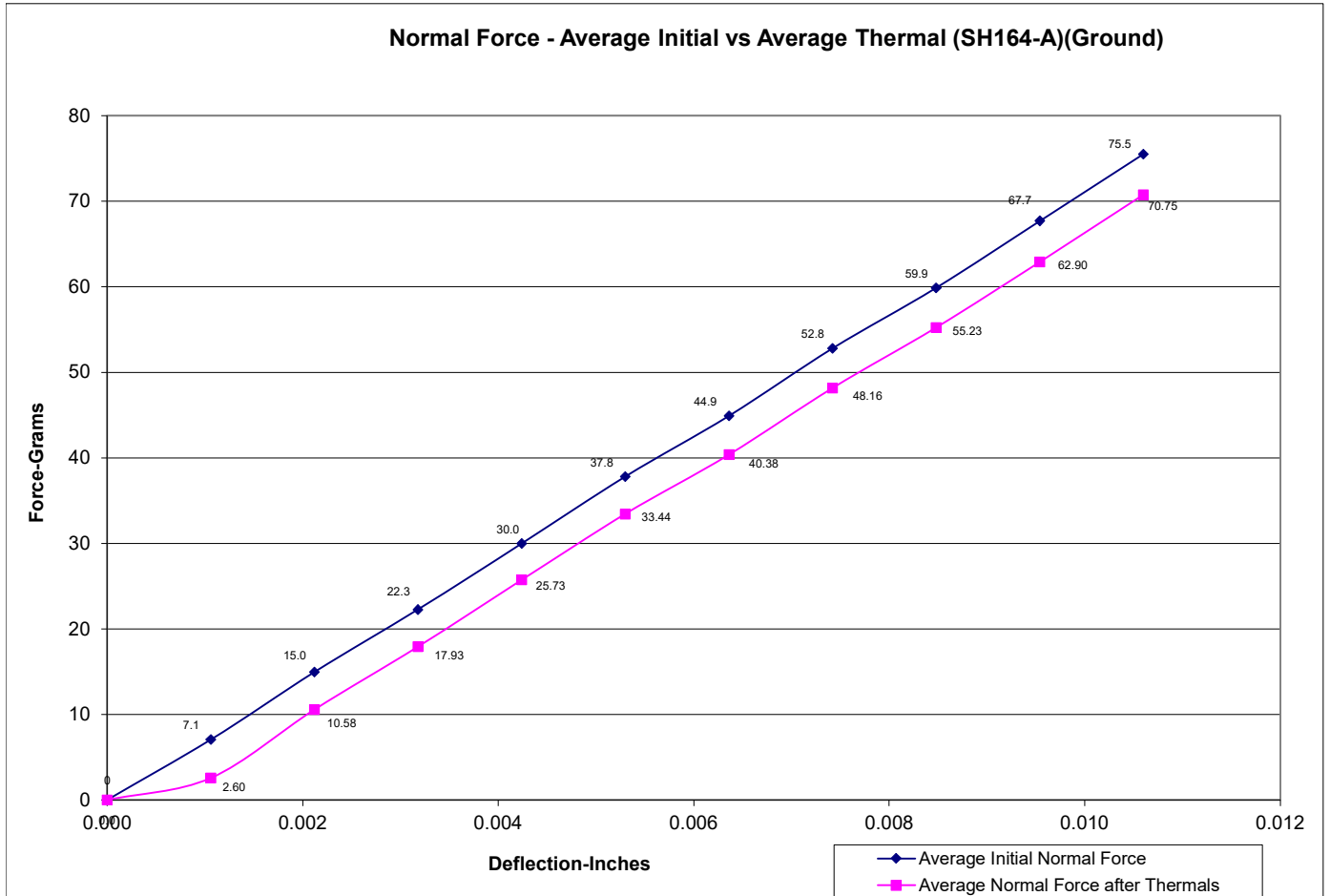


**DATA SUMMARIES Continued**

**NVBF Ground pin SH164-A**

Initial	Deflections in inches Forces in Grams										
	<u>0.0011</u>	<u>0.0021</u>	<u>0.0032</u>	<u>0.0042</u>	<u>0.0053</u>	<u>0.0064</u>	<u>0.0074</u>	<u>0.0085</u>	<u>0.0095</u>	<u>0.0106</u>	<i>SET</i>
<b>Averages</b>	7.07	14.96	22.28	30.00	37.82	44.92	52.80	59.88	67.71	75.52	0.0001
<b>Min</b>	6.70	14.50	21.70	29.40	37.10	44.00	51.80	58.30	65.80	73.00	0.0000
<b>Max</b>	7.20	15.40	22.90	30.40	38.50	45.70	54.20	61.80	70.40	78.80	0.0003
<b>St. Dev</b>	0.177	0.280	0.382	0.356	0.418	0.629	0.937	1.239	1.687	1.993	0.0001
<b>Count</b>	10	10	10	10	10	10	10	10	10	10	10

After Thermals	Deflections in inches Forces in Grams										
	<u>0.0011</u>	<u>0.0021</u>	<u>0.0032</u>	<u>0.0042</u>	<u>0.0053</u>	<u>0.0064</u>	<u>0.0074</u>	<u>0.0085</u>	<u>0.0095</u>	<u>0.0106</u>	<i>SET</i>
<b>Averages</b>	2.60	10.58	17.93	25.73	33.44	40.38	48.16	55.23	62.90	70.75	0.0008
<b>Min</b>	0.00	7.10	14.70	22.60	30.20	37.40	45.60	52.50	59.50	66.90	0.0003
<b>Max</b>	5.70	13.70	20.90	28.60	36.20	43.30	50.80	57.90	65.60	73.50	0.0012
<b>St. Dev</b>	2.155	2.246	2.142	2.022	2.087	2.083	1.932	1.960	1.997	2.157	0.0003
<b>Count</b>	10	10	10	10	10	10	10	10	10	10	10



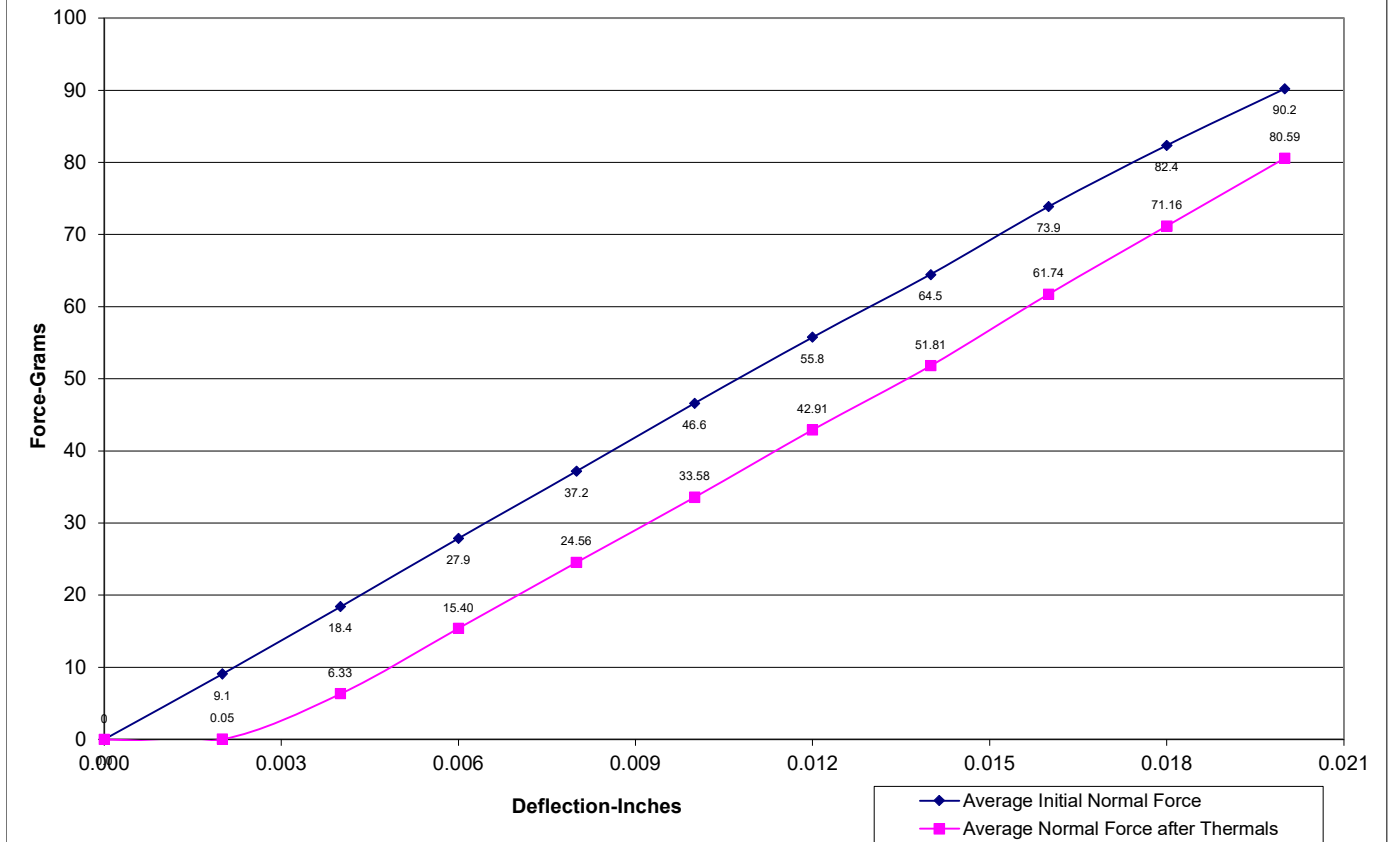
**DATA SUMMARIES Continued**

**NVBM MFBL pin SH164-A**

Initial	Deflections in inches Forces in Grams										
	<u>0.0020</u>	<u>0.0040</u>	<u>0.0060</u>	<u>0.0080</u>	<u>0.0100</u>	<u>0.0120</u>	<u>0.0140</u>	<u>0.0160</u>	<u>0.0180</u>	<u>0.0200</u>	<i>SET</i>
<b>Averages</b>	9.09	18.40	27.89	37.18	46.59	55.75	64.46	73.88	82.36	90.21	0.0007
<b>Min</b>	7.90	16.10	25.60	35.10	44.80	53.80	62.50	71.80	80.20	88.00	0.0002
<b>Max</b>	9.80	20.00	29.90	39.80	49.60	59.00	67.80	76.90	85.40	93.70	0.0009
<b>St. Dev</b>	0.671	1.133	1.226	1.360	1.500	1.650	1.794	1.823	1.903	2.097	0.0003
<b>Count</b>	8	8	8	8	8	8	8	8	8	8	8

After Thermals	Deflections in inches Forces in Grams										
	<u>0.0020</u>	<u>0.0040</u>	<u>0.0060</u>	<u>0.0080</u>	<u>0.0100</u>	<u>0.0120</u>	<u>0.0140</u>	<u>0.0160</u>	<u>0.0180</u>	<u>0.0200</u>	<i>SET</i>
<b>Averages</b>	0.05	6.33	15.40	24.56	33.58	42.91	51.81	61.74	71.16	80.59	0.0029
<b>Min</b>	-0.10	3.60	11.80	20.40	29.70	38.60	47.10	56.70	66.50	75.20	0.0020
<b>Max</b>	0.50	9.20	19.00	28.60	37.90	47.30	56.40	67.00	76.30	86.40	0.0038
<b>St. Dev</b>	0.185	1.772	2.151	2.628	2.899	3.028	3.237	3.652	3.780	4.193	0.0006
<b>Count</b>	8	8	8	8	8	8	8	8	8	8	8

**Normal Force - Average Initial vs Average Thermal (SH164-A)(MFBL)**



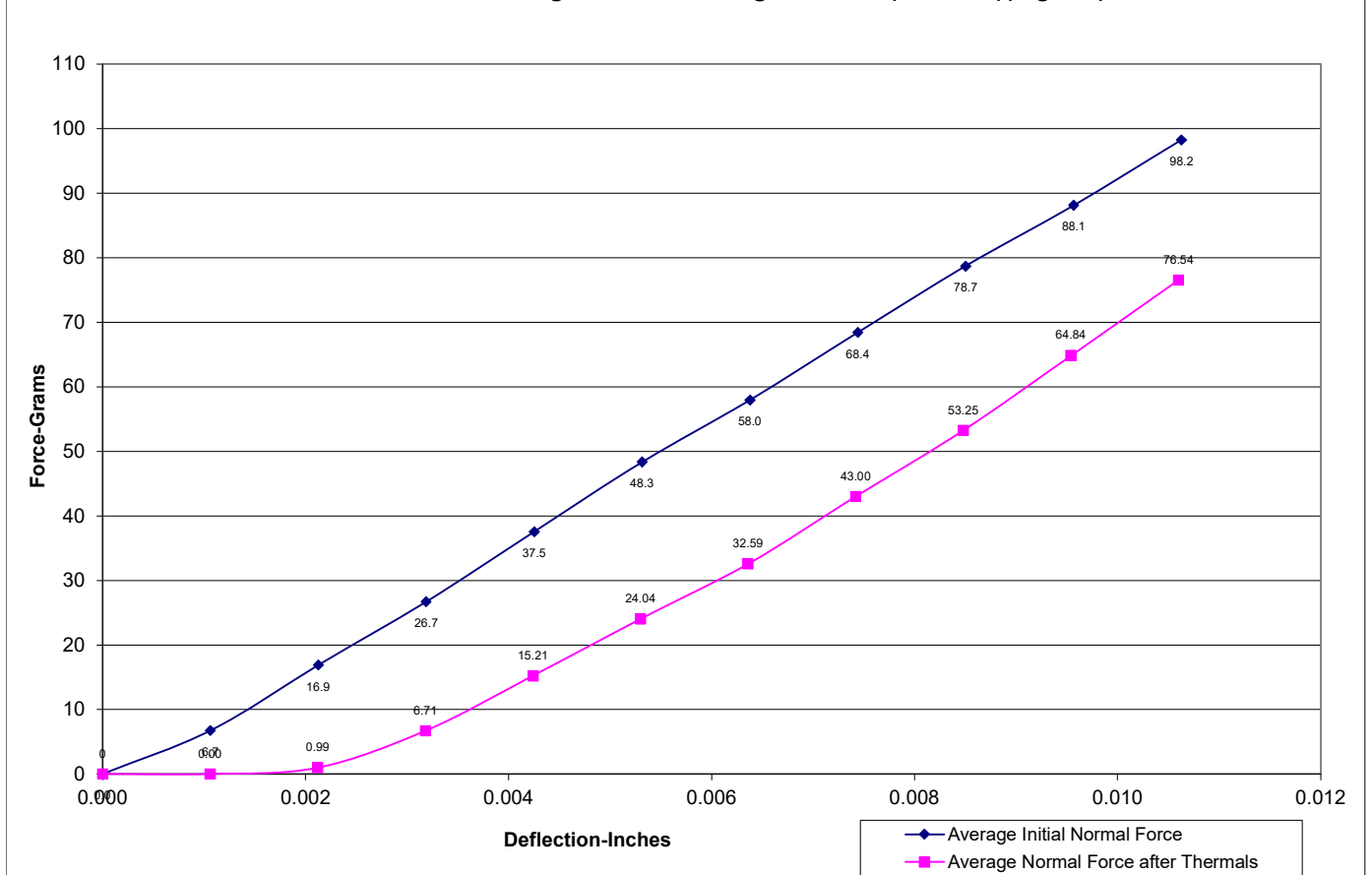
**DATA SUMMARIES Continued**

**NVBM Signal pin SH164-B**

Initial	Deflections in inches Forces in Grams										
	<u>0.0011</u>	<u>0.0021</u>	<u>0.0032</u>	<u>0.0043</u>	<u>0.0053</u>	<u>0.0064</u>	<u>0.0074</u>	<u>0.0085</u>	<u>0.0096</u>	<u>0.0106</u>	<i>SET</i>
<b>Averages</b>	6.74	16.89	26.71	37.54	48.34	57.95	68.41	78.70	88.11	98.23	0.0003
<b>Min</b>	4.90	15.30	24.10	33.80	43.30	51.60	60.70	69.60	77.60	86.50	0.0003
<b>Max</b>	8.80	19.10	29.30	42.60	55.30	66.90	79.20	91.40	101.90	113.50	0.0004
<b>St. Dev</b>	1.257	1.655	2.072	2.917	3.917	5.013	6.302	7.439	8.409	9.288	0.0001
<b>Count</b>	8	8	8	8	8	8	8	8	8	8	8

After Thermals	Deflections in inches Forces in Grams										
	<u>0.0011</u>	<u>0.0021</u>	<u>0.0032</u>	<u>0.0042</u>	<u>0.0053</u>	<u>0.0064</u>	<u>0.0074</u>	<u>0.0085</u>	<u>0.0095</u>	<u>0.0106</u>	<i>SET</i>
<b>Averages</b>	0.00	0.99	6.71	15.21	24.04	32.59	43.00	53.25	64.84	76.54	0.0020
<b>Min</b>	0.00	0.00	3.60	13.30	20.50	27.20	36.70	45.60	56.30	66.50	0.0017
<b>Max</b>	0.00	1.80	8.80	18.70	29.00	38.80	49.80	62.30	76.00	89.00	0.0024
<b>St. Dev</b>	0.000	0.759	1.738	1.669	2.732	4.237	5.212	6.220	6.928	7.400	0.0002
<b>Count</b>	8	8	8	8	8	8	8	8	8	8	8

**Normal Force - Average Initial vs Average Thermal (SH164-B)(Signals)**

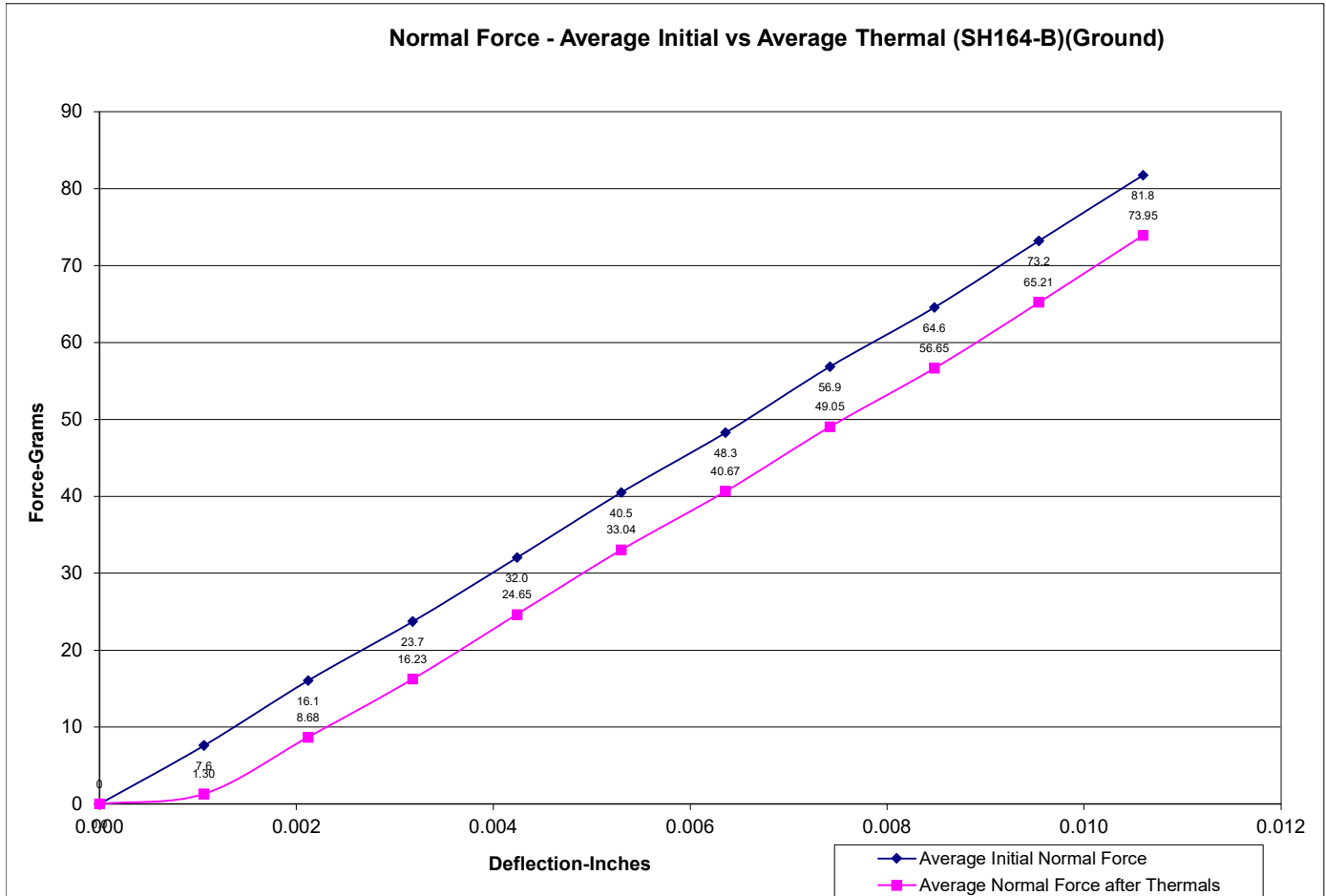


**DATA SUMMARIES Continued**

**NVBM Ground pin SH164-B**

Initial	Deflections in inches Forces in Grams										
	<u>0.0011</u>	<u>0.0021</u>	<u>0.0032</u>	<u>0.0042</u>	<u>0.0053</u>	<u>0.0064</u>	<u>0.0074</u>	<u>0.0085</u>	<u>0.0095</u>	<u>0.0106</u>	<i>SET</i>
<b>Averages</b>	7.60	16.06	23.72	32.03	40.49	48.30	56.86	64.56	73.21	81.77	0.0001
<b>Min</b>	6.50	13.90	20.30	27.50	34.90	41.60	49.10	55.70	62.80	70.00	0.0000
<b>Max</b>	8.30	17.50	25.70	35.20	44.00	52.30	61.30	69.60	78.80	88.00	0.0002
<b>St. Dev</b>	0.583	1.146	1.774	2.502	3.132	3.616	4.066	4.590	5.196	5.690	0.0001
<b>Count</b>	10	10	10	10	10	10	10	10	10	10	10

After Thermals	Deflections in inches Forces in Grams										
	<u>0.0011</u>	<u>0.0021</u>	<u>0.0032</u>	<u>0.0042</u>	<u>0.0053</u>	<u>0.0064</u>	<u>0.0074</u>	<u>0.0085</u>	<u>0.0095</u>	<u>0.0106</u>	<i>SET</i>
<b>Averages</b>	1.30	8.68	16.23	24.65	33.04	40.67	49.05	56.65	65.21	73.95	0.0010
<b>Min</b>	-0.10	5.40	13.00	20.50	28.80	35.90	43.50	50.80	58.50	67.30	0.0005
<b>Max</b>	4.40	12.60	19.90	28.00	36.60	44.20	53.20	61.30	70.40	79.50	0.0014
<b>St. Dev</b>	1.623	2.474	2.366	2.419	2.499	2.526	2.906	3.243	3.637	3.965	0.0003
<b>Count</b>	10	10	10	10	10	10	10	10	10	10	10



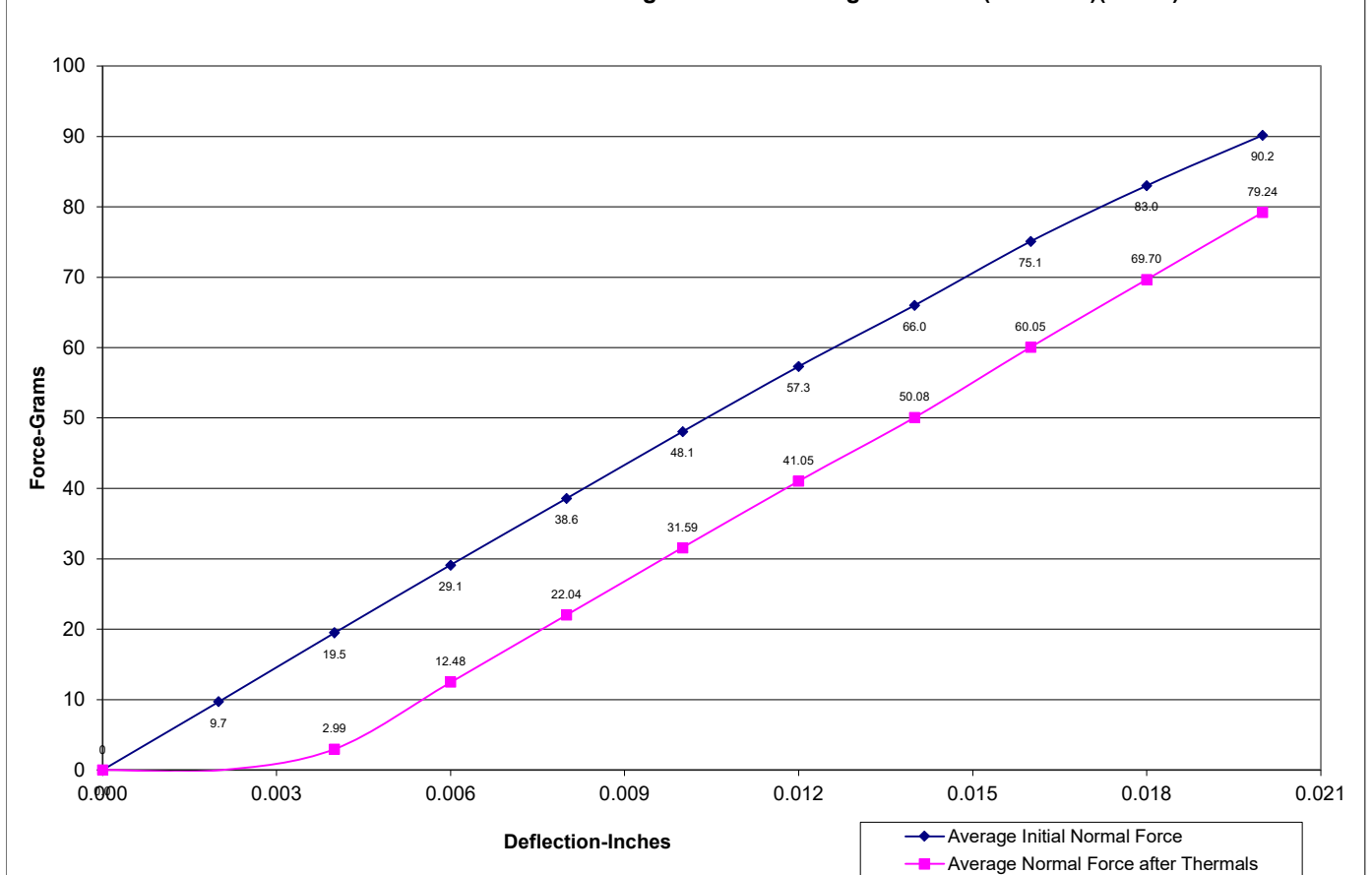
**DATA SUMMARIES Continued**

**NVBM MFBL pin SH164-B**

Initial	Deflections in inches Forces in Grams										
	<u>0.0020</u>	<u>0.0040</u>	<u>0.0060</u>	<u>0.0080</u>	<u>0.0100</u>	<u>0.0120</u>	<u>0.0140</u>	<u>0.0160</u>	<u>0.0180</u>	<u>0.0200</u>	<i>SET</i>
<b>Averages</b>	9.70	19.49	29.13	38.60	48.08	57.33	66.04	75.09	83.04	90.19	0.0008
<b>Min</b>	9.30	18.60	27.40	36.10	44.60	52.90	60.80	69.00	76.30	83.00	0.0003
<b>Max</b>	10.10	20.10	30.20	40.30	50.10	59.70	68.90	78.10	87.10	96.00	0.0011
<b>St. Dev</b>	0.256	0.610	1.182	1.663	2.238	2.832	3.331	3.879	4.250	4.647	0.0003
<b>Count</b>	8	8	8	8	8	8	8	8	8	8	8

After Thermals	Deflections in inches Forces in Grams										
	<u>0.0020</u>	<u>0.0040</u>	<u>0.0060</u>	<u>0.0080</u>	<u>0.0100</u>	<u>0.0120</u>	<u>0.0140</u>	<u>0.0160</u>	<u>0.0180</u>	<u>0.0200</u>	<i>SET</i>
<b>Averages</b>	-0.01	2.99	12.48	22.04	31.59	41.05	50.08	60.05	69.70	79.24	0.0035
<b>Min</b>	-0.10	0.70	9.20	18.20	28.20	38.20	47.40	57.20	66.70	75.70	0.0027
<b>Max</b>	0.00	6.90	16.20	25.70	35.10	44.00	53.50	64.00	74.00	84.10	0.0040
<b>St. Dev</b>	0.035	2.001	2.186	2.305	2.307	2.254	2.349	2.479	2.601	2.936	0.0004
<b>Count</b>	8	8	8	8	8	8	8	8	8	8	8

**Normal Force - Average Initial vs Average Thermal (SH164-B)(MFBL)**



**DATA SUMMARIES Continued****INSULATION RESISTANCE (IR):**

<b>Pin to Pin 1</b>			
	Mated	Unmated	Unmated
Minimum	<b>NVBM/NVBF</b>	<b>NVBM</b>	<b>NVBF</b>
<b>Initial</b>	9000	9000	9000
<b>Thermal</b>	9000	9000	9000
<b>Humidity</b>	9000	6300	9000

<b>Pin to Pin 2</b>			
	Mated	Unmated	Unmated
Minimum	<b>NVBM/NVBF</b>	<b>NVBM</b>	<b>NVBF</b>
<b>Initial</b>	9000	9000	9000
<b>Thermal</b>	9000	9000	9000
<b>Humidity</b>	9000	9000	9000

<b>Row to Row</b>			
	Mated	Unmated	Unmated
Minimum	<b>NVBM/NVBF</b>	<b>NVBM</b>	<b>NVBF</b>
<b>Initial</b>	9000	9000	9000
<b>Thermal</b>	9000	9000	9000
<b>Humidity</b>	9000	9000	9000

<b>Pin to Ground 1</b>			
	Mated	Unmated	Unmated
Minimum	<b>NVBM/NVBF</b>	<b>NVBM</b>	<b>NVBF</b>
<b>Initial</b>	9000	9000	9000
<b>Thermal</b>	9000	9000	9000
<b>Humidity</b>	5700	5700	9000

<b>Pin to Ground 2</b>			
	Mated	Unmated	Unmated
Minimum	<b>NVBM/NVBF</b>	<b>NVBM</b>	<b>NVBF</b>
<b>Initial</b>	9000	9000	9000
<b>Thermal</b>	9000	9000	9000
<b>Humidity</b>	9000	9000	9000

**DATA SUMMARIES Continued****DIELECTRIC WITHSTANDING VOLTAGE (DWV):**

<b>Voltage Rating Summary</b>	
<b>Minimum</b>	<b>NVCF/NVBM</b>
<b>Break Down Voltage</b>	600
<b>Test Voltage</b>	450
<b>Working Voltage</b>	150

<b>Pin to Pin 1</b>	
<b>Initial Test Voltage</b>	Passed
<b>After Thermal Test Voltage</b>	Passed
<b>After Humidity Test Voltage</b>	Passed

<b>Pin to Pin 2</b>	
<b>Initial Test Voltage</b>	Passed
<b>After Thermal Test Voltage</b>	Passed
<b>After Humidity Test Voltage</b>	Passed

<b>Row to Row</b>	
<b>Initial Test Voltage</b>	Passed
<b>After Thermal Test Voltage</b>	Passed
<b>After Humidity Test Voltage</b>	Passed

<b>Pin to Ground 1</b>	
<b>Initial Test Voltage</b>	Passed
<b>After Thermal Test Voltage</b>	Passed
<b>After Humidity Test Voltage</b>	Passed

<b>Pin to Ground 2</b>	
<b>Initial Test Voltage</b>	Passed
<b>After Thermal Test Voltage</b>	Passed
<b>After Humidity Test Voltage</b>	Passed

### DATA SUMMARIES Continued

**LLCR Durability:**

- 1) A total of 256 signals and 32 ground points were measured.
- 2) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 3) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 4) The following guidelines are used to categorize the changes in LLCR as a result of stress.
  - a.  $\leq +5.0$  mOhms: -----Stable
  - b.  $+5.1$  to  $+10.0$  mOhms: -----Minor
  - c.  $+10.1$  to  $+15.0$  mOhms:-----Acceptable
  - d.  $+15.1$  to  $+50.0$  mOhms:-----Marginal
  - e.  $+50.1$  to  $+1000$  mOhms-----Unstable
  - f.  $>+1000$  mOhms:-----Open Failure

**NVBM-DP-04-RA-S-2-B-C/NVBF-DP-04-VT-S-2-B-C**

LLCR Measurement Summaries by Pin Type				
Date	2025/5/12	2025/5/22	2025/6/2	2025/6/12
Room Temp (Deg C)	22	22	22	22
Rel Humidity (%)	42	46	42	54
Technician	Tony Wagoner	Tony Wagoner	Tony Wagoner	Tony Wagoner
mOhm values	Actual Initial	Delta 100 Cycles	Delta Therm Shck	Delta Humidity
Pin Type: Signal 1				
Average	21.05	0.25	0.7	0.67
St. Dev.	4.6	0.23	0.5	0.59
Min	14	0	0	0
Max	27.81	1.36	3.64	3.31
Summary Count	256	256	256	256
Total Count	256	256	256	256
Pin Type: GND 1				
Average	5.64	0.14	0.51	0.5
St. Dev.	1.04	0.12	0.34	0.23
Min	4.51	0	0.01	0.18
Max	6.93	0.56	1.35	1.09
Summary Count	32	32	32	32
Total Count	32	32	32	32

LLCR Delta Count by Category						
	Stable	Minor	Acceptable	Marginal	Unstable	Open
mOhms	$\leq 5$	$>5 \ \& \ \leq 10$	$>10 \ \& \ \leq 15$	$>15 \ \& \ \leq 50$	$>50 \ \& \ \leq 1000$	$>1000$
100 Cycles	288	0	0	0	0	0
Therm Shck	288	0	0	0	0	0
Humidity	288	0	0	0	0	0

### DATA SUMMARIES Continued

**LLCR Durability:**

- 1) A total of 1024 signals and 128 ground points were measured.
- 2) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 3) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 4) The following guidelines are used to categorize the changes in LLCR as a result of stress.
  - a.  $\leq +5.0$  mOhms: -----Stable
  - b.  $+5.1$  to  $+10.0$  mOhms: -----Minor
  - c.  $+10.1$  to  $+15.0$  mOhms:-----Acceptable
  - d.  $+15.1$  to  $+50.0$  mOhms:-----Marginal
  - e.  $+50.1$  to  $+1000$  mOhms-----Unstable
  - f.  $>+1000$  mOhms:-----Open Failure

**NVBM-DP-16-RA-S-2-B-A/NVBF-DP-16-VT-S-2-B-A**

LLCR Measurement Summaries by Pin Type				
Date	2025/8/18	2025/8/27	2025/9/10	2025/9/23
Room Temp (Deg C)	22	22	22	22
Rel Humidity (%)	56	42	45	57
Technician	Tony Wagoner	Tony Wagoner	Tony Wagoner	Tony Wagoner
<b>mOhm values</b>				
	Actual	<b>Delta</b>	<b>Delta</b>	<b>Delta</b>
	<b>Initial</b>	<b>100 Cycles</b>	<b>Therm Shck</b>	<b>Humidity</b>
<b>Pin Type: Signal 1</b>				
Average	22.4	0.34	0.35	0.39
St. Dev.	4.68	0.35	0.35	0.38
Min	14.26	0	0	0
Max	31.32	2.68	4.74	5.17
Summary Count	1024	1024	1024	1024
Total Count	1024	1024	1024	1024
<b>Pin Type: GND 1</b>				
Average	8.1	0.21	0.2	0.2
St. Dev.	0.94	0.21	0.21	0.19
Min	6.5	0	0	0
Max	9.73	1.44	1.43	1.41
Summary Count	128	128	128	128
Total Count	128	128	128	128

LLCR Delta Count by Category						
	Stable	Minor	Acceptable	Marginal	Unstable	Open
mOhms	$\leq 5$	$>5 \ \& \ \leq 10$	$>10 \ \& \ \leq 15$	$>15 \ \& \ \leq 50$	$>50 \ \& \ \leq 1000$	$>1000$
<b>100 Cycles</b>	<b>1152</b>	<b>0</b>	<b>0</b>	<b>0</b>	<b>0</b>	<b>0</b>
<b>Therm Shck</b>	<b>1152</b>	<b>0</b>	<b>0</b>	<b>0</b>	<b>0</b>	<b>0</b>
<b>Humidity</b>	<b>1151</b>	<b>1</b>	<b>0</b>	<b>0</b>	<b>0</b>	<b>0</b>

### DATA SUMMARIES Continued

**LLCR Thermal Aging:**

- 1) A total of 256 signals and 32 ground points were measured.
- 2) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 3) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 4) The following guidelines are used to categorize the changes in LLCR as a result of stress.
  - a.  $\leq +5.0$  mOhms: -----Stable
  - b.  $+5.1$  to  $+10.0$  mOhms:-----Minor
  - c.  $+10.1$  to  $+15.0$  mOhms: -----Acceptable
  - d.  $+15.1$  to  $+50.0$  mOhms: -----Marginal
  - e.  $+50.1$  to  $+1000$  mOhms: -----Unstable
  - f.  $>+1000$  mOhms:-----Open Failure

**NVBM-DP-04-RA-S-2-B-C/NVBF-DP-04-VT-S-2-B-C**

LLCR Measurement Summaries by Pin Type		
Date	2025/5/12	2025/5/27
Room Temp (Deg C)	22	22
Rel Humidity (%)	42	42
Technician	Tony Wagoner	Tony Wagoner
<b>mOhm values</b>	<b>Actual Initial</b>	<b>Delta Thermal</b>
<b>Pin Type: Signal 1</b>		
Average	20.92	2
St. Dev.	4.58	1.61
Min	13.75	0.13
Max	27.6	9.54
Summary Count	256	256
Total Count	256	256
<b>Pin Type: GND 1</b>		
Average	5.62	0.94
St. Dev.	0.99	0.53
Min	4.51	0.32
Max	6.93	2.83
Summary Count	32	32
Total Count	32	32

LLCR Delta Count by Category						
	Stable	Minor	Acceptable	Marginal	Unstable	Open
<b>mOhms</b>	$\leq 5$	$>5 \ \& \ \leq 10$	$>10 \ \& \ \leq 15$	$>15 \ \& \ \leq 50$	$>50 \ \& \ \leq 1000$	$>1000$
<b>Thermal</b>	<b>273</b>	<b>15</b>	<b>0</b>	<b>0</b>	<b>0</b>	<b>0</b>

### DATA SUMMARIES Continued

**LLCR Gas Tight:**

- 1) A total of 160 signals and 32 ground points were measured.
- 2) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 3) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 4) The following guidelines are used to categorize the changes in LLCR as a result of stress.
  - a.  $\leq +5.0$  mOhms: -----Stable
  - b.  $+5.1$  to  $+10.0$  mOhms: -----Minor
  - c.  $+10.1$  to  $+15.0$  mOhms: -----Acceptable
  - d.  $+15.1$  to  $+50.0$  mOhms: -----Marginal
  - e.  $+50.1$  to  $+1000$  mOhms: -----Unstable
  - f.  $>+1000$  mOhms: -----Open Failure

**NVBM-DP-04-RA-S-2-B-C/NVBF-DP-04-VT-S-2-B-C**

LLCR Measurement Summaries by Pin Type		
Date	2024/6/14	2024/6/20
Room Temp (Deg C)	22	22
Rel Humidity (%)	53	54
Technician	Richard Ison	Richard Ison
<b>mOhm values</b>	<b>Actual</b>	<b>Delta</b>
	<b>Initial</b>	<b>Acid Vapor</b>
<b>Pin Type: Signal 1</b>		
Average	20.97	0.4
St. Dev.	5.07	0.4
Min	14.18	0.01
Max	28.11	2.71
Summary Count	160	160
Total Count	160	160
<b>Pin Type: GND 1</b>		
Average	5.74	0.08
St. Dev.	0.96	0.08
Min	4.1	0
Max	7.19	0.39
Summary Count	32	32
Total Count	32	32

LLCR Delta Count by Category						
	Stable	Minor	Acceptable	Marginal	Unstable	Open
<b>mOhms</b>	$\leq 5$	$>5 \ \& \ \leq 10$	$>10 \ \& \ \leq 15$	$>15 \ \& \ \leq 50$	$>50 \ \& \ \leq 1000$	$>1000$
<b>Acid Vapor</b>	<b>192</b>	<b>0</b>	<b>0</b>	<b>0</b>	<b>0</b>	<b>0</b>

### DATA SUMMARIES Continued

**LLCR Shock & Vibration:**

- 1). A total of 256 signals and 32 ground points were measured.
- 2). EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 3). The following guidelines are used to categorize the changes in LLCR as a result of stress.
  - a.  $\leq +5.0$  mOhms: -----Stable
  - b.  $+5.1$  to  $+10.0$  mOhms: -----Minor
  - c.  $+10.1$  to  $+15.0$  mOhms: -----Acceptable
  - d.  $+15.1$  to  $+50.0$  mOhms: -----Marginal
  - e.  $+50.1$  to  $+1000$  mOhms -----Unstable
  - f.  $>+1000$  mOhms: -----Open Failure

**NVBM-DP-04-RA-S-2-B-C/NVBF-DP-04-VT-S-2-B-C**

LLCR Measurement Summaries by Pin Type		
Date	2025/5/16	2025/5/19
Room Temp (Deg C)	22	22
Rel Humidity (%)	43	47
Technician	Tony Wagoner	Tony Wagoner
<b>mOhm values</b>	<b>Actual</b>	<b>Delta</b>
	<b>Initial</b>	<b>Shock-Vib</b>
Pin Type: Signal 1		
Average	20.91	0.59
St. Dev.	4.58	1.3
Min	13.72	0
Max	28.2	9.78
Summary Count	256	256
Total Count	256	256
Pin Type: GND 1		
Average	5.55	0.15
St. Dev.	0.98	0.15
Min	4.44	0.01
Max	6.96	0.62
Summary Count	32	32
Total Count	32	32

LLCR Delta Count by Category						
	Stable	Minor	Acceptable	Marginal	Unstable	Open
<b>mOhms</b>	<b><math>\leq 5</math></b>	<b><math>&gt;5 \ \&amp; \ \leq 10</math></b>	<b><math>&gt;10 \ \&amp; \ \leq 15</math></b>	<b><math>&gt;15 \ \&amp; \ \leq 50</math></b>	<b><math>&gt;50 \ \&amp; \ \leq 1000</math></b>	<b><math>&gt;1000</math></b>
<b>Shock-Vib</b>	<b>279</b>	<b>9</b>	<b>0</b>	<b>0</b>	<b>0</b>	<b>0</b>

**Nanosecond Event Detection:**

Shock and Vibration Event Detection Summary	
Contacts tested	60
Test Condition	C, 100g's, 6ms, Half-Sine
Shock Events	0
Test Condition	V-B, 7.56 rms g
Vibration Events	0
<b>Total Events</b>	<b>0</b>

**EQUIPMENT AND CALIBRATION SCHEDULES****Equipment #:** TCT-04**Description:** Dillon Quantrol TC21 25-1000 mm/min series test stand**Manufacturer:** Dillon Quantrol**Model:** TC2 I series test stand**Serial #:** 04-1041-04**Accuracy:** Speed Accuracy: +/- 5% of indicated speed; Speed Accuracy: +/- 5% of indicated speed;

... Last Cal: 05/29/2025, Next Cal: 05/29/2026

**Equipment #:** MO-11**Description:** Switch/Multimeter**Manufacturer:** Keithley**Model:** 3706**Serial #:** 120169**Accuracy:** See Manual

... Last Cal: 09/11/2025, Next Cal: 09/11/2026

**Equipment #:** TSC-01**Description:** Vertical Thermal Shock Chamber**Manufacturer:** Cincinnati Sub Zero**Model:** VTS-3-6-6-SC/AC**Serial #:** 10-VT14993**Accuracy:** See Manual

... Last Cal: 06/30/2025, Next Cal: 06/30/2026

**Equipment #:** THC-05**Description:** Temperature/Humidity Chamber (Chamber Room)**Manufacturer:** Thermotron**Model:** SM-8-3800**Serial #:** 05 23 00 02**Accuracy:** See Manual

... Last Cal: 11/14/2025, Next Cal: 11/14/2026

**Equipment #:** OV-05**Description:** Forced Air Oven, 5 Cu. Ft., 120 V (Chamber Room)**Manufacturer:** Sheldon Mfg.**Model:** CE5F**Serial #:** 02008008**Accuracy:** +/- 5 deg. C

... Last Cal: 02/03/2025, Next Cal: 02/03/2026

**Equipment #:** HPT-01**Description:** Hipot Safety Tester**Manufacturer:** Vitrek**Model:** V73**Serial #:** 019808**Accuracy:**

... Last Cal: 05/15/2025, Next Cal: 05/15/2026

**EQUIPMENT AND CALIBRATION SCHEDULES****Equipment #:** PS-02**Description:** Power Supply**Manufacturer:** Hewlett-Packard**Model:** 6033A**Serial #:** N/A**Accuracy:** See Manual

... Last Cal: CALIBRATION NOT REQUIRED.

**Equipment #:** MO-04**Description:** Multimeter /Data Acquisition System**Manufacturer:** Keithley**Model:** 2700**Serial #:** 0798688**Accuracy:** See Manual

... Last Cal: 09/11/2025, Next Cal: 09/11/2026

**Equipment #:** SVC-01**Description:** Shock & Vibration Table**Manufacturer:** Data Physics**Model:** LE-DSA-10-20K**Serial #:** 10037**Accuracy:** See Manual

... Last Cal: 04/22/2025, Next Cal: 04/22/2026

**Equipment #:** ACLM-01**Description:** Accelerometer**Manufacturer:** PCB Piezotronics**Model:** 352C03**Serial #:** 115819**Accuracy:** See Manual

... Last Cal: 07/18/2025, Next Cal: 07/18/2026

**Equipment #:** ED-03**Description:** Event Detector**Manufacturer:** Analysis Tech**Model:** 32EHD**Serial #:** 1100604**Accuracy:** See Manual

... Last Cal: 10/31/2025, Next Cal: 10/31/2026